

DATA SHEET

SAA7388

Error correction and host interface
IC for CD-ROM (ELM)

Preliminary specification
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**Error correction and host interface IC
for CD-ROM (ELM)**

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1 FEATURES

- CD-ROM (Mode 1) and CD-I (Mode 2 - Form 1 and Form 2) formats supported
- Real-time error detection and correction in hardware
- Suitable for octal speed, $n = 8$.
- Maximum host transfer burst rate of 13.3 Mbyte/s
- Corrects two errors per symbol with erasure correction
- 36 kbit of on-chip error correction buffer RAM
- 12-byte command FIFO and 12-byte status FIFO
- Compatible with the Advanced Technology Attachment (ATA) register set and the Advanced Technology Attachment Program Interface (ATAPI) command set
- Operates with popular memories. (up to 128 kbyte SRAM; 1 to 16 Mbit DRAM, different speed grades, nibble or byte wide)
- Interface to Integrated Drive Electronics (IDE) bus without external bus drivers
- Q-to-W subcode buffering, de-interleaving and correction are supported
- Device can operate with audio RAMs. A RAM test allows bad segments to be identified.

2 GENERAL DESCRIPTION

The SAA7388 decoder is a block decoder buffer manager for high-speed CD-ROM applications that integrates real-time error correction and detection and host interface data transfer functions into a single chip.

The SAA7388 has an on-chip 36-kbit memory. This memory is used as a buffer memory for error and erasure corrections. The chip also has a buffer memory interface thus enabling the connection of SRAM up to 128 kbytes, or DRAM up to 16 Mbits. The on-chip memory is sufficient to buffer 1 sector of data. The external memory can buffer many more, depending on memory size.

The error corrector of the SAA7388 can perform 2-pass error correction in real-time. Buffer memory for this correction is integrated on-chip.

The SAA7388 has a host interface that is compatible with the SANYO LC89510 or OAK OTI-012 and also compatible with the ATA/IDE/ATAPI hard disc interface bus. (All ATAPI registers are present in hardware).

Supply of this Compact Disc IC does not convey an implied license under any patent right to use this IC in any Compact Disc application.

3 QUICK REFERENCE DATA

| SYMBOL | PARAMETER | MIN. | TYP. | MAX. | UNIT |
|-----------|-------------------------------|------|------|------|------|
| V_{DD1} | digital supply voltage 1 | 3.0 | 3.3 | 3.6 | V |
| V_{DD2} | digital supply voltage 2 | 4.5 | 5 | 5.5 | V |
| I_{DD} | supply current | – | 60 | – | mA |
| f_{clk} | clock frequency | 15.2 | 48 | 50.4 | MHz |
| T_{amb} | operating ambient temperature | 0 | – | +70 | °C |
| T_{stg} | storage temperature | –55 | – | +125 | °C |

4 ORDERING INFORMATION

| TYPE NUMBER | PACKAGE | | |
|-------------|---------|---|----------|
| | NAME | DESCRIPTION | VERSION |
| SAA7388GP | QFP80 | plastic quad flat package; 80 leads; lead length 1.95 mm; body 14 × 20 × 2.8 mm | SOT318-2 |

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5 BLOCK DIAGRAM

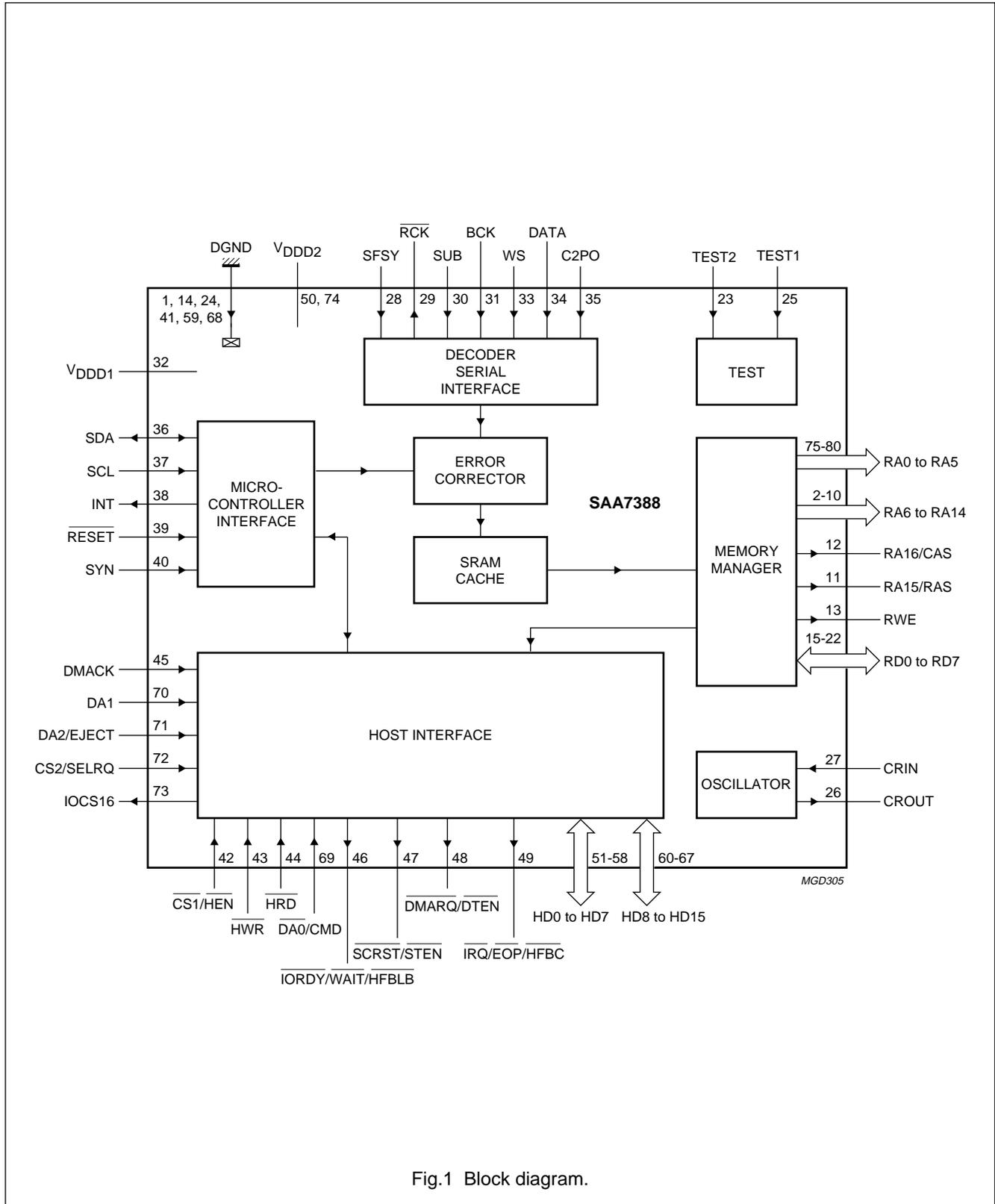


Fig.1 Block diagram.

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6 PINNING

| SYMBOL | PIN | I/O | DESCRIPTION |
|------------------|-----|-----|--|
| DGND1 | 1 | – | digital ground 1 |
| RA6 | 2 | O | buffer RAM address bus output line 6 |
| RA7 | 3 | O | buffer RAM address bus output line 7 |
| RA8 | 4 | O | buffer RAM address bus output line 8 |
| RA9 | 5 | O | buffer RAM address bus output line 9 |
| RA10 | 6 | O | buffer RAM address bus output line 10 |
| RA11 | 7 | O | buffer RAM address bus output line 11 (SRAM) only |
| RA12 | 8 | O | buffer RAM address bus output line 12 (SRAM) only |
| RA13 | 9 | O | buffer RAM address bus output line 13 (SRAM) only |
| RA14 | 10 | O | buffer RAM address bus output line 14 (SRAM) only |
| RA15/RAS | 11 | O | buffer RAM address bus output line 15 (SRAM) or RAS (DRAM) |
| RA16/CAS | 12 | O | buffer RAM address bus output line 16 (SRAM) or CAS (DRAM) |
| RWE | 13 | O | buffer RAM write enable output |
| DGND2 | 14 | – | digital ground 2 |
| RD0 | 15 | I/O | buffer RAM data bus bidirectional line 0 |
| RD1 | 16 | I/O | buffer RAM data bus bidirectional line 1 |
| RD2 | 17 | I/O | buffer RAM data bus bidirectional line 2 |
| RD3 | 18 | I/O | buffer RAM data bus bidirectional line 3 |
| RD4 | 19 | I/O | buffer RAM data bus bidirectional line 4 |
| RD5 | 20 | I/O | buffer RAM data bus bidirectional line 5 |
| RD6 | 21 | I/O | buffer RAM data bus bidirectional line 6 |
| RD7 | 22 | I/O | buffer RAM data bus bidirectional line 7 |
| TEST2 | 23 | I | test input 2 |
| DGND3 | 24 | – | digital ground 3 |
| TEST1 | 25 | I | test input 1 |
| CROUT | 26 | O | clock oscillator output |
| CRIN | 27 | I | clock oscillator input |
| SFSY | 28 | I | serial subcode input frame sync input |
| RCK | 29 | O | serial subcode clock output (active LOW) |
| SUB | 30 | I | serial input for Q-to-W subcode input |
| BCK | 31 | I | serial interface bit clock input |
| V _{DD1} | 32 | – | digital supply voltage 1 (3.3 V) |
| WS | 33 | I | serial interface word clock input |
| DATA | 34 | I | serial data input |
| C2PO | 35 | I | serial interface flag input |
| SDA | 36 | I/O | sub-CPU serial data input/output |
| SCL | 37 | I | sub-CPU serial clock input |
| INT | 38 | O | sub-CPU open-collector interrupt output |
| RESET | 39 | I | power-on reset input (active LOW) |
| SYN | 40 | I | sync signal input from sub-CPU |

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| SYMBOL | PIN | I/O | DESCRIPTION |
|--------------------------------------|-----|-----|--|
| DGND4 | 41 | – | digital ground 4 |
| $\overline{\text{CS1/HEN}}$ | 42 | I | host interface enable input (active LOW) |
| $\overline{\text{HWR}}$ | 43 | I | host interface write enable input (active LOW) |
| $\overline{\text{HRD}}$ | 44 | I | host interface read enable input (active LOW) |
| $\overline{\text{DMACK}}$ | 45 | I | DMA acknowledge input |
| $\overline{\text{IORDY/WAIT/HFBLB}}$ | 46 | O | host interface wait output (active LOW); 3-state control |
| $\overline{\text{SCRST/STEN}}$ | 47 | O | host interface status enable output ATAPI sub-CPU reset signal (active LOW) |
| $\overline{\text{DMARQ/DTEN}}$ | 48 | O | ATAPI DMA request host interface data enable output (active LOW); 3-state control |
| $\overline{\text{IRQ/EOP/HFBC}}$ | 49 | O | host interface end of process flag output ATAPI host interrupt request (active LOW); 3-state control |
| V _{DD2} | 50 | – | digital supply voltage 2 (5 V) |
| HD0 | 51 | I/O | host interface data bus input/output line 0 |
| HD1 | 52 | I/O | host interface database input/output line 1 |
| HD2 | 53 | I/O | host interface database input/output line 2 |
| HD3 | 54 | I/O | host interface data bus input/output line 3 |
| HD4 | 55 | I/O | host interface data bus input/output line 4 |
| HD5 | 56 | I/O | host interface data bus input/output line 5 |
| HD6 | 57 | I/O | host interface data bus input/output line 6 |
| HD7 | 58 | I/O | host interface data bus input/output line 7 |
| DGND5 | 59 | – | digital ground 5 |
| HD8 | 60 | I/O | host interface data bus input/output line 8 |
| HD9 | 61 | I/O | host interface data bus input/output line 9 |
| HD10 | 62 | I/O | host interface data bus input/output line 10 |
| HD11 | 63 | I/O | host interface data bus input/output line 11 |
| HD12 | 64 | I/O | host interface data bus input/output line 12 |
| HD13 | 65 | I/O | host interface data bus input/output line 13 |
| HD14 | 66 | I/O | host interface data bus input/output line 14 |
| HD15 | 67 | I/O | host interface data bus input/output line 15 |
| DGND6 | 68 | – | digital ground 6 |
| $\overline{\text{DA0/CMD}}$ | 69 | I | host interface data input (active LOW)/command select input host interface address line 0 |
| DA1 | 70 | I | ATAPI address line input 1 |
| DA2/EJECT | 71 | I | ATAPI address line input 2 |
| CS2/SELRQ | 72 | I | ATAPI chip select input 2 |
| IOCS16 | 73 | O | ATAPI 16-bit data select output |
| V _{DD2} | 74 | – | digital supply voltage 2 (5 V) |
| RA0 | 75 | O | buffer RAM address bus output line 0 |
| RA1 | 76 | O | buffer RAM address bus output line 1 |
| RA2 | 77 | O | buffer RAM address bus output line 2 |

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| SYMBOL | PIN | I/O | DESCRIPTION |
|--------|-----|-----|--------------------------------------|
| RA3 | 78 | O | buffer RAM address bus output line 3 |
| RA4 | 79 | O | buffer RAM address bus output line 4 |
| RA5 | 80 | O | buffer RAM address bus output line 5 |

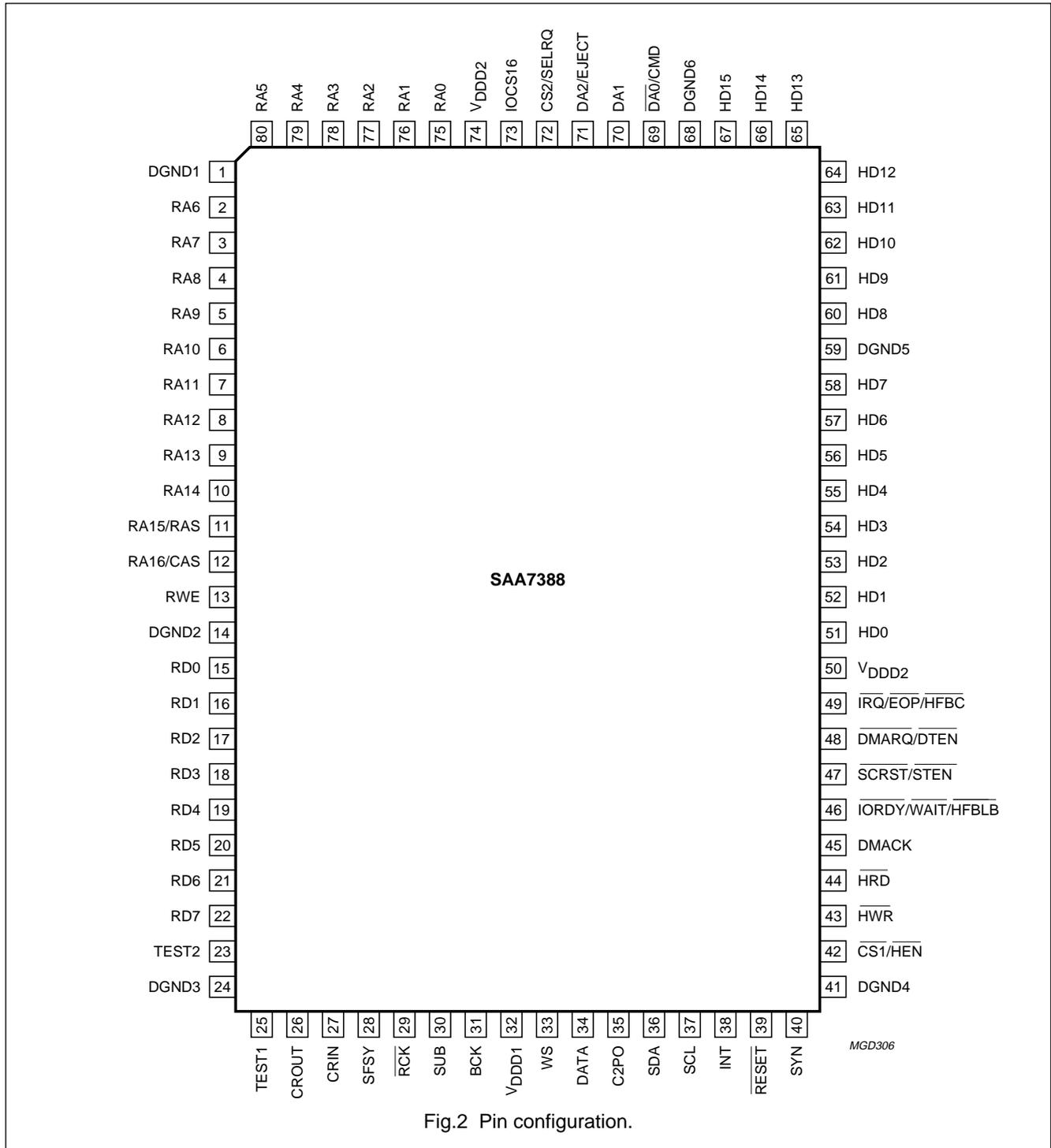


Fig.2 Pin configuration.

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6.1 Pin functions

6.1.1 RA0 TO RA14

External memory address signals.

6.1.2 RA16/CAS

External memory RA16 signal if SRAM or, CAS signal if DRAM.

6.1.3 RA15/RAS

External memory RA15 signal if SRAM or, RAS signal if DRAM.

6.1.4 RWE

Write output enable signal for external buffer memory. This is LOW when the SAA7388 wants to write data into the external memory.

6.1.5 RD0 TO RD7

External buffer memory bidirectional data signals.

6.1.6 SFSY

Frame sync for the Q-to-W subcode, indicates when P-channel is available by a HIGH-to-LOW transition. Frame 0 is also indicated by no transition on this line.

6.1.7 \overline{RCK}

In response to SFSY going LOW data is clocked into the SAA7388 before each rising edge using this clock output.

6.1.8 SUB

Q-to-W subcode is input in response to \overline{RCK} in 3-wire EIAJ mode or WS in "V4" mode compatible with the SAA7345.

6.1.9 BCK

Bit clock for the serial data input from the CD decoder.

6.1.10 WS

Word clock for the serial data input from the CD decoder.

6.1.11 DATA

Serial data input from the CD decoder. This may be either I²S-bus or EIAJ 16-bit format.

6.1.12 C2PO

Error flag from the CD decoder. A HIGH indicates that a byte has not been corrected by the C2 error corrector and therefore is not valid. This is taken into account by the SAA7388 error corrector.

6.1.13 SDA

Sub-CPU bidirectional data signal. This signal forms part of the 3-wire serial interface between the SAA7388 and the sub-CPU.

6.1.14 SCL

Sub-CPU sync signal. This signal forms part of the 3-wire serial interface between the SAA7388 and the sub-CPU. This signal is used to synchronize data transfers between the sub-CPU and the SAA7388.

6.1.15 INT

Sub-CPU interrupt signal. This active LOW output signals to the sub-CPU that the SAA7388 has an interrupt request.

6.1.16 \overline{RESET}

Forcing this input LOW resets the SAA7388.

6.1.17 SYN

Sub-CPU clock signal. This signal forms part of the 3-wire serial interface between the SAA7388 and the sub-CPU. This signal is the sub-CPU driven bit clock used to synchronize the signals on the SDA line.

6.1.18 $\overline{CS1/HEN}$

In the ATAPI mode this is the host chip select 1 address signal. In the Sanyo and Oak compatibility modes setting this input LOW enables the host interface.

6.1.19 \overline{HWR}

This active LOW signal is the host write request.

6.1.20 \overline{HRD}

This active LOW signal is the host read request.

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6.1.21 DMACK

This signal is used in the ATAPI and Oak compatibility modes during DMA transfers. The host pulls this signal LOW in response to a $\overline{\text{DMARQ}}$ request to indicate that it is ready to transfer data.

If this signal is not being used then it must be pulled HIGH for SAA7388 to operate correctly.

6.1.22 $\overline{\text{IORDY}}/\overline{\text{WAIT}}/\overline{\text{HFBLB}}$

In the ATAPI mode this signal is negated to extend the host transfer cycle of any host register access. It is used in PIO transfers. When $\overline{\text{IORDY}}$ is not negated it is in a high-impedance state.

In the Sanyo compatibility mode the function of this signal depends on the SELRQ input. If SELRQ is HIGH then $\overline{\text{WAIT}}$ is set LOW to extend the host transfer cycle. If SELRQ is LOW then $\overline{\text{WAIT}}$ acts as the DRQ signal in a DMA transfer.

In the Oak compatibility mode this signal is the Host First Byte Latch signal. A rising edge on this signal is used to latch the first byte in a pseudo 16-bit DMA read. HFBLB can only be HIGH when pseudo 16-bit DMA transfer mode is selected.

6.1.23 $\overline{\text{SCRST}}/\overline{\text{STEN}}$

In the ATAPI or Oak compatibility mode this signal is pulled LOW to reset the sub-CPU in response to a reset command from the host.

In the Sanyo compatibility mode this signal is pulled LOW to signal to the host that status bytes are available for transfer.

6.1.24 $\overline{\text{DMARQ}}/\overline{\text{DTEN}}$

In the ATAPI or Oak compatibility mode this signal is asserted when the SAA7388 is ready to transfer data between the host and itself. In ATAPI single word and Oak DMA transfers this occurs at every word. In ATAPI multi-word DMA transfers this occurs at the start of the transfer.

In the Sanyo compatibility mode this signal is pulled LOW to signal to the host that data bytes are available for transfer.

6.1.25 $\overline{\text{IRQ}}/\overline{\text{EOP}}/\overline{\text{HFBC}}$

In the ATAPI mode this active HIGH signal indicates a host interrupt request. It is asserted when the sub-CPU writes to the ITRG register and is negated when the host reads the status register or writes to the command register.

In the Sanyo compatibility mode this signal is set LOW when the last data byte is transferred to or from the host.

In the Oak compatibility mode this is the Host First Byte Cycle output and is HIGH while the first byte in the pseudo 16-bit DMA transfer is accessed. It should be used to inhibit non-DMA transactions while the first byte is latched.

6.1.26 HD0 TO HD15

These are the bidirectional Host Data signals. In the Sanyo and Oak compatibility modes HD8 to HD15 are never used.

6.1.27 $\overline{\text{DA0}}/\text{CMD}$

In the ATAPI mode this is the host Data Address 0 signal. In the Sanyo and Oak compatibility modes this input selects between command or data transfers.

6.1.28 DA1

This is the ATAPI Data Address 1 signal.

6.1.29 DA2/ EJECT

In the ATAPI mode this is the Data Address 2 signal. In the Oak compatibility mode this is the door switch input pin. Its state is reflected in the TSTAT register.

6.1.30 CS2/SELRQ

In the ATAPI mode this is the Chip Select 2 signal. In the Oak and Sanyo compatibility mode this is the data transfer mode select input. It is used to select between PIO and DMA transfers.

6.1.31 IOCS16

This open-collector signal is used in the ATAPI mode to signal to the host that a 16-bit data port has been addressed. It is not activated during DMA transfers.

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7 FUNCTIONAL DESCRIPTION

The SAA7388 is comprised of four main blocks; a CD player interface, an error corrector, a host interface and a memory manager. These four blocks operate in parallel. All receive and send data to the buffer memory via the memory manager. A 36-kbit on-chip SRAM has been incorporated to allow high-speed data read operations for the error corrector.

The SAA7388 performs simultaneous data input buffering, error correction and host data transfer.

7.1 CD-DSP interface and data input

The input data is synchronized, decoded, and written to the buffer RAM. The input data format is software programmable.

The synchronization is achieved using a sync detector and a sync interpolator. The sync detector detects the sync pattern in every sector while the interpolator avoids sync loss when no sync is found. The detector and interpolator can be individually enabled and disabled under software control.

After decoding, each full sector of data (2352 bytes) comprising sync, header, sub-header and parity fields is written to the buffer RAM.

7.2 Error correction and EDC check

Error correction and detection is performed on each sector after it is written to the buffer RAM.

The SAA7388 buffers flag and data of sectors to be corrected in a 9-bit, 4096 words on-chip RAM memory. For erasure correction, no external 9-bit memory is required.

The standard error correction algorithm can be programmed, and supports mode 1 and mode 2 form 1 and form 2 discs.

After error correction, an electronic data check is executed.

When this EDC check is also complete, the sector header and sub-header is written to 8 header registers, and a decode complete interrupt is generated.

The microcontroller can then read the decoder status, the sector header and sub-header and the sector start address from the SAA7388.

7.3 Host interface

The host interface controls data transfers between the SAA7388 and an external microcontroller. The host interface can be programmed to operate in three modes. In the Sanyo compatibility mode the host interface is functionally compatible with the Sanyo LC89510 block decoder. In the Oak compatibility mode the host interface is functionally compatible with the Oak OTI-012 controller chip in enhanced mode.

In the ATAPI mode the interface meets the ATA Program Interface specification.

7.4 Subcode channel Q-to-W buffering

As well as buffering the main data, the SAA7388 can also be used to buffer R-to-W subcode data in buffer memory. Two buffer modes exist, raw mode and cooked mode. In the raw mode, data is written to an external RAM without any processing being performed. In the cooked mode, the Q-channel data is extracted, the Q-channel CRC is calculated, the R-to-W data is de-interleaved and the residues of each R-to-W frame are calculated. These residues make it easier to correct errors in the data.

7.5 External buffer memory

It is possible to use the SAA7388 with different external RAM memories. From 0 to 128 kbyte SRAMs or to 16-Mbit DRAMs are possible. Memories may be nibble or byte wide (allowing 2, 8 or 16 Mbits). Selection is performed under software control.

Unique to the SAA7388 is its ability to work with partly defective DRAMs. The SAA7388 offers the possibility to use a DRAM with bytes in error.

A RAM test is executed under microcontroller control. This RAM test indicates defective segments to the microcontroller which keeps a list of which bad sectors to avoid. The list can be stored in the buffer memory and/or the microcontrollers own memory.

7.6 Sub-CPU registers

This section describes the registers in the SAA7388. The operation of the registers varies depending on whether they are being read from or written to, and the host mode selected.

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Table 1 Sub-CPU registers during write

| # | AR | NAME | BIT 7 | BIT 6 | BIT 5 | BIT 4 | BIT 3 | BIT 2 | BIT 1 | BIT 0 | |
|----|-------|---------------------------|---|---|--------|---------------------------|---------------------------|---------------------------|----------|--------|--|
| 0 | 00000 | ADATA/ SBOUT | ATAPI Data register/Status Byte Output register | | | | | | | | |
| 1 | 00001 | IFCTRL | CMDIEN | DTEIEN | DECIEN | $\overline{\text{CMDBK}}$ | $\overline{\text{DTWAI}}$ | $\overline{\text{STWAI}}$ | DOUTEN | SOUTEN | |
| 2 | 00010 | DBCL | Data Byte Count register bits 7 to 0 | | | | | | | | |
| 3 | 00011 | DBCH | Data Byte Count register bits 15 to 8 | | | | | | | | |
| 4 | 00100 | DACL | Data Address Counter register bits 7 to 0 | | | | | | | | |
| 5 | 00101 | DACH | Data Address Counter register bits 15 to 8 | | | | | | | | |
| 6 | 00110 | DTRG | Data Transfer Trigger register | | | | | | | | |
| 7 | 00111 | DTACK | Data Transfer Acknowledge register | | | | | | | | |
| 8 | 01000 | WAL | Write Address register bits 7 to 0 | | | | | | | | |
| 9 | 01001 | WAH | Write Address register bits 15 to 8 | | | | | | | | |
| 10 | 01010 | CTRL0 | DECEN | lookahead | E01RQ | AUTOQ | ERAMRQ | WRRQ | ECCRQ | ENCODE | |
| 11 | 01011 | CTRL1 | SYIEN | SYDEN | DSCREN | COWREN | MODRQ | FORMRQ | MBCKRQ | SHDREN | |
| 12 | 01100 | PTL | Block Pointer register bits 7 to 0 | | | | | | | | |
| 13 | 01101 | PTH | Block Pointer register bits 15 to 8 | | | | | | | | |
| 14 | 01110 | | | | | | | | | | |
| 15 | 01111 | $\overline{\text{RESET}}$ | reserved | | | | | HSEL | | | |
| 16 | 10000 | DACHH | mem | Data Address Counter register bits 20 to 16 | | | | | | | |
| 17 | 10001 | WAHH | Write Address register bits 20 to 16 | | | | | | | | |
| 18 | 10010 | PTHH | Block Pointer register bits 20 to 16 | | | | | | | | |
| 19 | 10011 | SUB_L | Subcode Address register bits 7 to 0 | | | | | | | | |
| 20 | 10100 | SUB_H | Subcode Address register bits 9 and 8 | | | | | | | | |
| 21 | 10101 | | | | | | | | | | |
| 22 | 10110 | INCNF | IISmode | div 1 | div 0 | QWmode | QWon | QWcook | RAM test | 0 | |
| 23 | 10111 | MEMS | 0 | PRIORITY | | 0 | RFRSH | WIDTH | STATIC | CACHE | |
| 24 | 11000 | ASTAT | ATAPI Status register | | | | | | | | |
| 25 | 11001 | ITRG | Host Interrupt Trigger register | | | | | | | | |
| 26 | 11010 | ADRADR | ATAPI Drive Address register | | | | | | | | |
| 27 | 11011 | ASAMT | ATAPI SAM TAG register | | | | | | | | |
| 28 | 11100 | DTCTR | res. | DMAMODE | UDMA | SUBIEN | RDRV | TRANT | | | |
| 29 | 11101 | ADRSEL | ATAPI Drive Select register | | | | | | | | |
| 30 | 11110 | AINTR | ATAPI Interrupt Reason register | | | | | | | | |
| 31 | 11111 | AERR | ATAPI Error register | | | | | | | | |

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Table 2 Sub-CPU registers during read

| # | AR | NAME | BIT 7 | BIT 6 | BIT 5 | BIT 4 | BIT 3 | BIT 2 | BIT 1 | BIT 0 |
|----|-------|-----------------|--|--------------------------|--------------------------|--------------------------|---------------------------|---|--------------------------|--------------------------|
| 0 | 00000 | APCMD/ COMIN | ATAPI packet command data/command input register | | | | | | | |
| 1 | 00001 | IFSTAT | $\overline{\text{CMDI}}$ | $\overline{\text{DTEI}}$ | $\overline{\text{DECI}}$ | $\overline{\text{SUBI}}$ | $\overline{\text{DTBSY}}$ | $\overline{\text{SRSTI}}/\overline{\text{STBSY}}$ | $\overline{\text{DTEN}}$ | $\overline{\text{STEN}}$ |
| 2 | 00010 | DBCL | Data Byte Count register bits 7 to 0 | | | | | | | |
| 3 | 00011 | DBCH | Data Byte Count register bits 15 to 8 | | | | | | | |
| 4 | 00100 | HEAD0 | Minutes/ File Number | | | | | | | |
| 5 | 00101 | HEAD1 | Seconds/ Channel Number | | | | | | | |
| 6 | 00110 | HEAD2 | Frames/ Submode | | | | | | | |
| 7 | 00111 | HEAD3 | Mode/ Coding Information | | | | | | | |
| 8 | 01000 | PTL | Block Pointer register bits 7 to 0 | | | | | | | |
| 9 | 01001 | PTH | Block Pointer register bits 15 to 8 | | | | | | | |
| 10 | 01010 | WAL | Write Address register bits 7 to 0 | | | | | | | |
| 11 | 01011 | WAH | Write Address register bits 15 to 8 | | | | | | | |
| 12 | 01100 | STAT0 | CRCOK | ILSYNC | NOSYNC | LBLK | USHORT | SBLK | ERR | UCEB |
| 13 | 01101 | STAT1 | MINERR | SECERR | BLKERR | MODERR | SH0ERR | SH1ERR | SH2ERR | SH3ERR |
| 14 | 01110 | STAT2 | RMOD3 | RMOD2 | RMOD1 | RMOD0 | MODE | FORM | RFORM1 | RFORM2 |
| 15 | 01111 | STAT3 | VALST | | CBLK | | | | | |
| 16 | 10000 | PTHH | Block Pointer register bits 20 to 16 | | | | | | | |
| 17 | 10001 | WAHH | Write Address register bits 20 to 16 | | | | | | | |
| 18 | 10010 | SUB_L | Subcode Address register bits 7 to 0 | | | | | | | |
| 19 | 10011 | SUB_H | Subcode Address register bits 9 and 8 | | | | | | | |
| 20 | 10100 | | | | | | | | | |
| 21 | 10101 | | | | | | | | | |
| 22 | 10110 | | | | | | | | | |
| 23 | 10111 | | | | | | | | | |
| 24 | 11000 | | | | | | | | | |
| 25 | 11001 | HCON | Oak Host Configuration register | | | | | | | |
| 26 | 11010 | ACMD | ATAPI Command register | | | | | | | |
| 27 | 11011 | ASAMT | ATAPI SAM TAG register | | | | | | | |
| 28 | 11100 | ADCTR | ATAPI Device Control register | | | | | | | |
| 29 | 11101 | ADRSEL | ATAPI Drive Select register | | | | | | | |
| 30 | 11110 | AINTR | ATAPI Interrupt Reason register | | | | | | | |
| 31 | 11111 | AFEAT | ATAPI Features register | | | | | | | |

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7.7 Register Descriptions

7.7.1 SBOUT/ADATA

This is a 12 byte FIFO used to transfer data from the sub-CPU to the host.

In the Sanyo and Oak compatibility mode writing to this register starts a status byte transfer. In this mode if the SOUTEN bit in the IFCTRL register has been set to logic 1, writing to the SBOUT register sets the STBSY bit to logic 0. If the STWAI bit is set to logic 0, \overline{STEN} is immediately set LOW to inform the host computer that the status byte is ready to be read from.

If the STWAI bit is set to logic 1 and the \overline{DTEN} bit in the IFSTAT register is also set to logic 1, both the \overline{STEN} pin and the STBSY will go LOW. However, if the STWAI bit is set to logic 0, and the \overline{DTEN} bit is set to logic 0, then \overline{STEN} is held HIGH until the DTEN bit goes HIGH, thereafter it goes LOW.

7.7.2 COMIN/ APCMD

During the ATAPI mode this register is used to read the program command sent by the host. The program command can only be received if the appropriate mode has been selected (see Table 22) and a data transfer has been started (see DTRG register).

During Sanyo and Oak compatibility modes this register is a 12 byte FIFO which is used to transfer commands from the host to the sub-CPU. If reading this register empties the command FIFO then CMDI is set to logic 1 and further reads from the register will return FFH.

7.7.3 IFCTRL

The IFCTRL register provides control over the host interface. Resetting the chip will clear all bits. In the ATAPI mode, only, bits 7 to 5 have any effect.

Table 3 IFCTRL register bits

| BIT | NAME | DESCRIPTION |
|-----|--------------------|---|
| 7 | CMDIEN | Enable bits for CMDI, DTEI and DECI. These are interrupt masks, enabling/disabling the sub-CPU interrupt pin. They do not affect the bits in the IFSTAT register. If set to logic 1, the corresponding interrupt is enabled. It should be noted that these masks do not clear the interrupts. |
| 6 | DTEIEN | |
| 5 | DECIEN | |
| 4 | \overline{CMDBK} | Command break enable. If set to logic 0 then the command break function is enabled and if the host writes to the COMIN FIFO then any data or status byte transfers in progress will be terminated. If set to logic 1 then this operation is disabled. The data transfer interrupt DTEI is not generated by a command break. |
| 3 | \overline{DTWAI} | Data transfer \overline{WAIT} enable. Setting this bit to logic 0 enables the data \overline{WAIT} function. The data \overline{WAIT} function allows the SAA7388 to delay hardware execution of the data transfer until a status byte transfer has been completed. Disabling the data \overline{WAIT} function allows data transfers to take place independently of status byte transfers. |
| 2 | \overline{STWAI} | Status byte transfer \overline{WAIT} enable. This bit acts in a similar way to the \overline{DTWAI} bit except it controls the status \overline{WAIT} function. The status \overline{WAIT} function allows the SAA7388 to delay hardware execution of the status transfer until a data byte transfer has been completed. Disabling the data \overline{WAIT} function allows status transfers to take place independently of data transfers. |
| 1 | DOUTEN | Data output enable. DOUTEN enables/disables data transfers. When set to logic 0, all data transfers in progress are aborted. |
| 0 | SOUTEN | Status output enable. SOUTEN enables/disables status byte transfers. When set to logic 0, the status FIFO register is reset to empty and all status byte transfers in progress are aborted. |

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7.7.4 IFSTAT

The IFSTAT register indicates the state of the host interface. In the ATAPI mode, only bits 7 to 2 have any meaning.

Table 4 IFSTAT register bits

| BIT | NAME | DESCRIPTION |
|-----|---------------------------------|---|
| 7 | $\overline{\text{CMDI}}$ | Command interrupt. In the ATAPI mode this bit is asserted when the host has written to the ATAPI command register (see ACMD register) and the drive is selected. It is also asserted when the host writes the execute drive diagnostic command (90H) to the ATAPI command register, regardless of whether the drive is selected. It is negated when the sub-CPU reads the ACMD register. In the Sanyo and Oak compatibility modes this bit is asserted while there are command bytes waiting in the COMIN FIFO. It is negated when the COMIN FIFO is empty. |
| 6 | $\overline{\text{DTEI}}$ | Data transfer end interrupt. This bit is asserted at the end of data transfer. It is negated when the sub-CPU writes to the DTACK register. If the ATAPI mode is selected this bit is also asserted when a program command has been received and after a sub-CPU memory transfer. |
| 5 | $\overline{\text{DECI}}$ | Decoder interrupt. This bit is asserted when a new sector is available. It is negated by reading the STAT3 register. |
| 4 | $\overline{\text{SUBI}}$ | Subcode interrupt. This bit is asserted when a new subcode is available. It is negated by reading the SUB_H register. |
| 3 | $\overline{\text{DTBSY}}$ | Data transfer busy. This bit indicates if a data transfer is taking place. It is asserted by writing to the DTRG register and is negated at the end of the transfer. |
| 2 | $\overline{\text{SRSTI/STBSY}}$ | SRST bit interrupt/status transfer busy. In the ATAPI mode this bit is asserted when the host writes to the ATAPI device control register and sets the SRST bit. It is negated when the sub-CPU reads the ADCTR register. It should be noted that if this bit is asserted in the ATAPI mode then the sub-CPU interrupt will also be asserted. The $\overline{\text{SRSTI}}$ interrupt cannot be disabled. In the Sanyo and Oak compatibility modes this bit indicates if a status byte transfer is taking place. It is asserted by writing to the SBOU register and is negated when the host has emptied the status FIFO. |
| 1 | $\overline{\text{DTEN}}$ | Data transfer and status transfer. These bits reflect the state of the $\overline{\text{DTEN}}$ and $\overline{\text{STEN}}$ pins in the Sanyo and Oak compatibility modes. They are updated at the end of a host read or write. |
| 0 | $\overline{\text{STEN}}$ | |

7.7.5 DBCL AND DBCH

The Data Byte Counter is used by the sub-CPU to control the number of bytes that are transferred in a data transfer. In the ATAPI mode all 16 bits are available while in the Sanyo and Oak compatibility modes only 15 bits are available with bit 7 of DBCH indicating the state of $\overline{\text{DTEI}}$ (see Table 4). During memory-to-host data transfers the data byte counter is decremented after every host read. During host-to-memory data transfers the data byte counter is decremented as data is written into external buffer memory.

7.7.6 DAQL, DACH AND DACHH

This 21-bit write-only register is used to specify the external buffer address of the first byte of the data block to be transferred to the host.

Once the address has been set, it is incremented automatically as successive bytes are transferred with the host. It should be noted that pointer operation is asynchronous from host read/write operation. For this reason, counter increments are not coincident with host transfer operations.

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Bit 7 of the DACHH register specifies which memory is accessed. If the bit is clear then the address refers to the external memory, if the bit is set then the address refers to the 4 kbyte internal memory. The internal memory should not be accessed during error correction.

This register should be written to before each data transfer because its value will be undefined at the end of the previous transfer.

7.7.7 PTL, PTH AND PTHH

This register holds a 21-bit pointer to the external buffer memory address of the head of the current data block after correction.

The SAA7388 defines the minute byte in the header to be at the head of the block, and the 12 sync bytes at the tail of the block. Each block contained in the buffer is taken to be 2352 bytes.

The controller can transfer the decoded block back to the host by copying the address of this register to the DACL, DACH and DACHH pointers after a decoder interrupt.

When the WRRQ bit in the CTRL0 register is set to logic 1, this pointer is updated at the sync signal of every 2352 byte clocks.

7.7.8 WAL, WAH AND WAHH

These registers contain a 21-bit address of where raw data from the drive is written to the external buffer memory. The pointer is automatically incremented during data transfer. The pointer should only be read while drive data writes to the buffer are disabled. If WAHH is written to while drive data write is enabled, then the new WA value will be used

for the first byte of the next sector. The new pointer value is temporarily stored in the PT register. This cannot be read after WA has been written to.

7.7.9 DTRG

Writing to this register starts a data transfer. The data written is discarded.

7.7.10 DTACK

Writing to this register clears the \overline{DTEI} interrupt. The data written is discarded.

7.7.11 HEAD0, HEAD1, HEAD2 AND HEAD3

These registers are used to hold the header and the sub-header data of the current block.

To read the header data set, the SHDREN bit in the CTRL1 register is set to logic 0; to read the sub-header data, SHDREN is set to logic 1.

If sub-header is selected, the registers will normally hold data from bytes 20 to 23. However, if the error flag for one of these bytes is set, then the byte is taken from the first sub-header field. (bytes 16 to 19.)

The error flags for header and sub-header can be read from the STAT1 register. No error correction is performed on header or sub-header.

Header and sub-header registers are valid directly after decoder interrupt, and as long as the VALST bit in the STAT3 register is LOW. In all write modes they contain information on the block whose header is pointed to by PTL, PTH and PTHH.

Table 5 HEAD registers

| SHDREN | REGISTER | CONTENTS |
|--------|----------|------------------------------------|
| 0 | HEAD0 | MINUTES (byte 12) |
| 0 | HEAD1 | SECONDS (byte 13) |
| 0 | HEAD2 | FRAMES (byte 14) |
| 0 | HEAD3 | MODE (byte 15) |
| 1 | HEAD0 | FILE NUMBER (byte 16 or 20) |
| 1 | HEAD1 | CHANNEL NUMBER (byte 17 or 21) |
| 1 | HEAD2 | SUBMODE NUMBER (byte 18 or 22) |
| 1 | HEAD3 | CODING INFORMATION (byte 19 or 23) |

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7.7.12 CTRL0

Resetting the chip sets all the bits in this register to logic 0.

Table 6 CTRL0 register

| BIT | NAME | FUNCTION |
|-----|-----------|---|
| 7 | DECEN | Disable decoding = 0; Enable decoding = 1. This bit enables/disables decoding functions. Disabling the decoding functions also disables the decoder interrupt. |
| 6 | lookahead | At interrupt PT, header refer to current block = 0; At interrupt PT, header refer to next block = 1. When this bit is set to logic 1 at decoder interrupt, CMA and header registers will give information on the next block instead of on the current block. The lookahead mode was included to provide support for bad RAMs, and to give the CPU better control on the blocks it wants to read. |
| 5 | E01RQ | Disable error correction of bytes = 0; Enable correction of CIRC mis-corrections = 1. Setting this bit to logic 0 instructs the error corrector not to correct bytes flagged as reliable by the CIRC error corrector. |
| 4 | AUTORQ | Disable automatic error correction = 0; Enable automatic error correction = 1. Requests automatic extraction of form bit during mode2 correction from sub-header data. |
| 3 | ERAMRQ | Disable erasure flag use = 0; Enable erasure flag use = 1. When set to logic 1, the SAA7388 will enable the use of erasure flag information for error correction. When set to logic 0, the SAA7388 will disable the use of erasure flag information for error correction. Use of erasure flags must be disabled SAA7388 when the CD-DSP does not output erasure flags and when the internal buffer RAM is disabled (which is necessary for repeat correction). |
| 2 | WRRQ | Disable data writes to the buffer and PTL updates = 0; Enables data writes to the buffer and PTL updates = 1. This bit enables/disables writes from the CD drive into the buffer. It also enables/disables pointer (PTL, PTH and PTHH) updates each time a block is received. When WRRQ is set to logic 1, data write will start from the first byte of the next block onwards. When WRRQ is set to logic 0, repeat correction is enabled. With WRRQ set to logic 0, the internal buffer RAM is disabled. |
| 1 | ECCRQ | Disable ECC correction = 0; Enable ECC correction = 1. When ECCRQ is set to logic 1 the blocks received by the SAA7388 will be error corrected before a decoder interrupt is generated. When ECCRQ is set to logic 0 no corrections are performed. The algorithm used is a QD, PD, QE, PE algorithm. In a first step, errors are corrected; in a second step, erasures are corrected. Correction data is read from the on-chip 36 kbit buffer memory. |
| 0 | ENCODE | Normal operation = 0; Test mode, do not use = 1, this bit must always be set to logic 0. |

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Table 7 Error correction modes

| DECEN | lookahead | WRRQ | ECCRQ | decoder mode |
|-------|-----------|------|-------|--------------------------------|
| 0 | X | X | X | decoder disable; note 1 |
| 1 | 0 | 0 | 0 | monitor only |
| 1 | 0 | 0 | 1 | repeat correction |
| 1 | 0 | 1 | 0 | write only |
| 1 | 0 | 1 | 1 | real-time correct, normal mode |
| 1 | 1 | 1 | 0 | write only, lookahead |
| 1 | 1 | 1 | 1 | real-time correct, lookahead |

Note

1. Where X = don't care.

7.7.13 CTRL1

The reset function clears all the flags in this register.

Table 8 CTRL1 register bits

| BIT | NAME | FUNCTION |
|-----|--------|--|
| 7 | SYIEN | Disable sync interpolation = 0; Enable sync interpolation = 1. Enabling SYIEN prevents loss of synchronization when an error occurs in a sync pattern during data read. |
| 6 | SYDEN | Disable sync detection = 0; Enable sync detection = 1. Enabling SYDEN synchronizes the decoder with the sync pattern detected in the input data. |
| 5 | DSCREN | Descramble disable (audio) = 0; Descramble enable = 1. This bit enables/disables descrambling. Setting this bit to logic 0 allows reading of raw data on disc, even audio signals. This bit should be set to logic 1 for CROM data. |
| 4 | COWREN | CRC with error correction disabled = 0; Detection errors are corrected = 1. This bit enables/disables rewriting of error bytes in the buffer during error correction. Setting the bit to logic 0 allows CRC checks without error correction. |
| 3 | MODRQ | Mode 1 request = 0; Mode 2 request = 1. This bit discriminates Mode 1/Mode 2. |
| 2 | FORMRQ | Form 1 request = 0; Form 2 request = 1. This bit discriminates Mode 2/Form 1 and Mode 2/Form 2. |
| 1 | MBCKRQ | Disable mode check function = 0; Enable mode check function = 1. If the mode specified in the mode byte does not correspond with the raw data mode bit and this bit is set to logic 1 then error correction and detection is disabled. |
| 0 | SHDREN | Header data on registers Head0 to Head3 = 0; Sub-header data on registers Head0 to Head3 = 1. This bit toggles header and sub-header data between registers HEAD0 to HEAD3. |

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7.7.14 STAT0

Resetting the chip clears all bits in this register.

Table 9 STAT0 register bits

| BIT | NAME | FUNCTION |
|-----|--------|---|
| 7 | CRCOK | Cyclic redundancy check not OK = 0; Cyclic redundancy check OK = 1. Set by the EDC in accordance with the results of the CRC check. |
| 6 | ILSYNC | Sync pattern detected at word count 0 to 1174 or 1176 onwards = 1. This bit is set to logic 1 if the sync pattern in the incoming data is detected between word counts 0 and 1174 or 1176 to infinity, and the decoder has been retimed. Due to the presence of the cache RAM, it is necessary to stop error correction also when long blocks have been detected. |
| 5 | NOSYNC | Sync pattern inserted by sync interpolator not coincident with data sync = 1. This bit is set to logic 1, if the word counter reaches 1175 and no sync pattern has been detected in the input data. It indicates that the sync interpolator circuit inserted a sync. |
| 4 | LBLK | With SYIEN = 0, no sync found. Data block size has been extended = 1. This bit is set to logic 1, if the sync interpolator was switched off, and if the sync interpolator indicated that sync insertion was necessary. This condition causes the block length to be extended. |
| 3 | | Reserved |
| 2 | SBLK | Short block indication = 1. This bit is set to logic 1 if the decoder is not retimed when a sync pattern is detected in an incorrect word location, and is ignored while the SYDEN bit is set to logic 0. |
| 1 | ERABLK | One or more bytes of the block are flagged with C2 flags = 1. This bit is set to logic 1 if one or more bytes of the current block contain erasures as indicated by the C2PO input. |
| 0 | UCEBLK | Uncorrectable errors in block = 1. This bit is set to logic 1 when one or more bytes of the current block remain in error after the error correction process. |

7.7.15 STAT1

Resetting the chip clears all bits in this register.

The bits in this register indicate the reliability of data in the HEAD0 to HEAD3 registers. Bits MINERR, SECERR, BLKERR and MODERR indicate errors in the minutes, seconds, frames and mode bytes in the header of the current block. Bits SH0ERR to SH3ERR indicate errors in the respective bytes in the sub-header.

Table 10 STAT1 register bits

| BIT 7 | BIT 6 | BIT 5 | BIT 4 | BIT 3 | BIT 2 | BIT 1 | BIT 0 |
|--------|--------|--------|-------|--------|--------|--------|--------|
| MINERR | SECERR | BLKERR | MODER | SH0ERR | SH1ERR | SH2ERR | SH3ERR |

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7.7.16 STAT2

The bits MODE and FORM in this register indicate the mode, form and correction scheme of the current frame.

Table 11 STAT2 register bits

| BIT 7 | BIT 6 | BIT 5 | BIT 4 | BIT 3 | BIT 2 | BIT 1 | BIT 0 |
|-------|-------|-------|-------|-------|-------|--------|--------|
| RMOD3 | RMOD2 | RMOD1 | RMOD0 | MODE | FORM | RFORM1 | RFORM2 |

Table 12 MODE and FORM bits

| MODE | FORM | SETTING |
|------|------|---|
| 0 | 0 | Mode 1 |
| 1 | 0 | Mode 2, Form 1 |
| X | 1 | Mode 2, Form 2 or ECC correction impossible |

The Mode bit is always copied from the CTRL1 register. The Form information is determined by the AUTORQ bit in the CTRL0 register. When this bit is set to logic 0, the Form information is copied from the CTRL1 register. When this bit is set to logic 1 the Form information is copied from the Mode header byte.

If correction of the block was impossible, FORM will be set to logic 1 regardless of the requested correction. This will happen under the following circumstances:

- An illegally synchronized block (ILSYNC = 1 or LBLK = 1)
- A data block specified as Mode 2, Form 2, or detected as Mode 2, Form 2
- A Mode 2 submode byte error detected during processing
- A mode mismatch detected by the mode check function (MCHQRQ = 1)
- A mode byte error detected by the mode check function (MCHQRQ = 1).

The RFORM2, RFORM1 bits contain a preview of the form bit for the next frame

Table 13 RFORM2 and RFORM1 bits

| RFORM1 | RFORM2 | MEANING |
|--------|--------|--------------------|
| 0 | 0 | Form 0 |
| 0 | 1 | Form 1 |
| 1 | X | error in form byte |

The RMOD3, RMOD2, RMOD1 and RMOD0 bits contain a preview of the next block MODE byte.

RMOD3 = bit7 # bit6 # bit5 # bit4 # bit3 # C2FLAG

RMOD2 = bit2 # C2FLAG

RMOD1 = bit1 # C2FLAG

RMOD0 = bit0 # C2FLAG

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Table 14 RMOD bits

| RMOD3 | RMOD2 | RMOD1 | RMOD0 | MEANING |
|-------|-------|-------|-------|---|
| 0 | 0 | 0 | 0 | mode 0 |
| 0 | 0 | 0 | 1 | mode 1 |
| 0 | 0 | 1 | 0 | mode 2 |
| 0 | 0 | 1 | 1 | mode 3 |
| 0 | 1 | 0 | 0 | mode 4 |
| 0 | 1 | 0 | 1 | mode 5 |
| 0 | 1 | 1 | 0 | mode 6 |
| 0 | 1 | 1 | 1 | mode 7 |
| 1 | X | X | X | mode > 7 or error in mode byte (note 1) |

Note

- Where X = don't care.

7.7.17 STAT3

Reading this register clears any DECI interrupts.

Table 15 STAT3 register bits

| BIT | NAME | MEANING |
|-----|-------|--|
| 7 | VALST | Registers associated with decoder interrupt valid = 0; Registers invalid = 1. This bit is a valid/invalid flag for the registers related to the decoder interrupt. After decoder interrupt, the sub-CPU must read out of all decoder registers before VALST goes HIGH. |
| 6 | – | – |
| 5 | CBLK | ECC not performed on current block = 0; ECC has been performed on current block = 1. This bit will go to logic 1 if ECC correction has been performed on the current block. |
| 2 | – | – |
| 1 | – | – |
| 0 | – | – |

7.7.18 $\overline{\text{RESET}}$

Writing to this register resets the SAA7388 and initializes all of the registers. The data written determines the host mode of SAA7388.

Table 16 $\overline{\text{RESET}}$ register bits

| BIT 7 | BIT 6 | BIT 5 | BIT 4 | BIT 3 | BIT 2 | BIT 1 | BIT 0 |
|----------|-------|-------|-------|-------|-------|-------|-------|
| reserved | | | | | HSEL | | |

The HSEL bits in the $\overline{\text{RESET}}$ register set the host interface mode. After a hardware reset the HSEL bits become 111. The SAA7388 will then wait until the sub-CPU writes to the $\overline{\text{RESET}}$ register and selects the host mode. After hardware reset 3-statable pins will be 3-state unless $\overline{\text{HRD}}$ is driven LOW.

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Table 17 HSEL bits

| HSEL CONTENT | | | SELECTED HOST INTERFACE | DESCRIPTION |
|--------------|-------|-------|-------------------------|--|
| BIT 2 | BIT 1 | BIT 0 | | |
| 0 | 0 | 0 | Sanyo | Sanyo compatible mode |
| 0 | 0 | 1 | ATAPI | ATAPI Mode |
| 0 | 1 | 0 | Oak | Oak compatible mode |
| 0 | 1 | 1 | unknown host | all host bus pins 3-state, default after h/w reset |
| others | | | reserved | for future enhancements |

7.7.19 SUB_L, SUB_H

This 10-bit register specifies the memory address of the subcode data block. This address will always be in the first 1 kbyte of memory.

7.7.20 INCNF

This register is used to specify the configuration of the input data path.

Table 18 INCNF register bits

| BIT | NAME | DESCRIPTION |
|-----|---------------------|---|
| 7 | IISmode | I ² S-bus mode = 0; EIAJ serial interface mode = 1. |
| 6 | div1 ⁽¹⁾ | If div1 and div0 = logic 0 then no oversampling (normal CDROM modes); If div1 = logic 0 and div0 = logic 1 then 2 times oversampling; If div1 = logic 1 and div0 = logic 0 then 4 times oversampling. |
| 5 | div0 ⁽¹⁾ | If div1 and div0 = logic 0 then no oversampling (normal CDROM modes); If div0 = logic 1 and div1 = logic 0 then 2 times oversampling; If div1 = logic 0 and div1 = logic 0 then 4 times oversampling. |
| 4 | QWmode | Selection of Q-to-W input format. Logic 0 = V4 mode; logic 1 = EIAJ mode. |
| 3 | QWon | Q-to-W interface enable. Logic 0 = off; logic 1 = on. |
| 2 | QWcook | Q-to-W interface cooking enable. Logic 0 = cooked mode; logic 1 = RAW mode. |
| 1 | RAMtest | External RAM test mode. Logic 0 = normal operation; logic 1 = RAM test mode. |
| 0 | – | – |

Note

- For subcode Q-to-W recovery, the BCK clock is used as a timing reference. It is possible to recover the Q-to-W subcode using the SAA7388, while at the same time the serial interface is programmed in oversampling mode for a DAC. Under such circumstances, it is necessary to tell the SAA7388 the oversampling factor.

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7.7.21 MEMS

This register is used to specify the configuration of the external buffer memory.

Table 19 MEMS register bits

| BIT | NAME | DESCRIPTION |
|-----|----------|---|
| 7 | | |
| 6 | PRIORITY | Host priority access. These bits specify the external memory accesses priority. |
| 5 | PRIORITY | |
| 4 | – | – |
| 3 | RFRSH | DRAM refresh rate. Setting this bit specifies a DRAM refresh rate of clock frequency/400. Clearing this bit specifies a rate of clock frequency/200. With a 33 MHz clock this bit should be set, while with a 16 MHz clock the bit should be clear. |
| 2 | WIDTH | DRAM width select. This bit should be set if the external DRAM has a nibble wide data bus. If the data bus is byte wide then this bit should be clear. |
| 1 | STATIC | SRAM/DRAM select. If the external buffer memory is DRAM then this bit should be cleared. If the memory is SRAM this bit should be set. |
| 0 | CACHE | CACHE memory select. If the internal cache is available then this bit should be clear. Setting this bit to logic 1 indicates that there is no internal cache memory. |

Table 20 Host priority access

| PRIORITY BITS | | ACCESS |
|---------------|-------|--|
| BIT 6 | BIT 5 | |
| 0 | 0 | only one host access has highest priority |
| 0 | 1 | two successive host accesses have highest priority |
| 1 | 0 | three successive host accesses have highest priority |
| 1 | 1 | four successive host accesses have highest priority |

7.7.22 ITRG

In the ATAPI mode writing to this register generates a host interrupt. This interrupt is cleared when the host reads the ATAPI status register or writes to the ATAPI command register.

In the Sanyo and Oak compatibility modes writing to this register has no effect.

7.7.23 ASTAT

This write only register is only available in the ATAPI mode; it is the ATAPI status register and is used to transfer status information to the ATAPI host.

Bit 7 of this register is the BSY bit and this is set by the SAA7388 whenever;

- SAA7388 is the selected drive and the host writes to the command register (ACMD)
- The host writes the execute drive diagnostic command (90H) to the command register
- The host writes to the device control register (ADCTR) and sets the SRST bit
- There is a hardware reset.

On reset this register is set to (80H).

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7.7.24 ACMD

This read only register is only available in the ATAPI mode; it is the ATAPI command register and is used to transfer commands from the host to the SAA7388.

The CMDI interrupt is generated when;

- The host writes to this register while the SAA7388 is the selected drive (the DRV bit in the ADRSEL register is equal to the RDRV bit in the DTCTR register)
- The host writes the execute drive diagnostic command (90H) to this register.

The BSY bit in the ASTAT register is also set under these conditions. If the sub-CPU reads this register while CMDI is asserted then it will be negated.

7.7.28 ADRSEL

Table 21 ADRSEL register bits

| BIT 7 | BIT 6 | BIT 5 | BIT 4 | BIT 3 | BIT 2 | BIT 1 | BIT 0 |
|-------|-------|-------|-------|-------|-------|-------|-------|
| 1 | 1 | 1 | DRV | – | – | – | – |

Bit 4 of this register is the DRV bit. When this bit is the same as the RDRV bit in the DTCTR register then the SAA7388 will be the selected ATAPI drive and will respond to host commands and produce host interrupts.

7.7.29 AINTR

This register is the ATAPI Interrupt Reason register.

7.7.30 AFEAT

This read only register is the ATAPI Features register.

7.7.31 AERR

This write only register is the ATAPI Error register.

7.7.25 ADRADR

This write only register is the ATAPI Drive Address register.

7.7.26 ASAMT

This register is the ATAPI Sector Number register.

7.7.27 ADCTR

This read only register is the ATAPI Device Control register. If the SRSTI interrupt is asserted then reading this register will negate it.

7.7.32 DTCTR - DATA TRANSFER CONTROL REGISTER

The DTCTR register controls data transfer flows in the host Interface block. On reset this register is cleared to all zeros except for the RDRV bit which is set to logic 1. This means that the SAA7388 will be set to drive 1 after a reset.

There are several possible data transfers through the SAA7388 host Interface block and these are selected using the TRANT bits. The transfers are described in the Table 23.

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Table 22 Data transfer control register bits

| BIT | FLAG | VERBOSE | DESCRIPTION |
|-----|---------|-------------------|---|
| 7 | res. | – | reserved |
| 6 | DMAMODE | DMA Mode Select | logic 0 = single-word; logic 1 = multi-word |
| 5 | UDMA | Use DMA | logic 1 = DMA; logic 0 = PIO |
| 4 | SUBIEN | SUBI Enable | logic 1 = interrupt enabled |
| 3 | RDRV | Real Drive Select | ATAPI drive number |
| 2 | TRANT | – | see Table 23 |
| 1 | | | |
| 0 | | | |

Table 23 TRANT transfer bits

| TRANT | | | FROM | TO | MAXIMUM BYTES | NOTES |
|-------|-------|-------|----------|----------|---------------|------------------------------------|
| BIT 2 | BIT 1 | BIT 0 | | | | |
| 0 | 0 | 0 | memory | host | 65535 (ATAPI) | DMA and PIO |
| | | | | | 32767 (Sanyo) | |
| 0 | 0 | 1 | host | memory | 65535 (ATAPI) | DMA and PIO |
| | | | | | 32767 (Sanyo) | |
| 0 | 1 | 0 | sub-CPU | memory | – | – |
| 0 | 1 | 1 | memory | sub-CPU | – | – |
| 1 | 0 | 0 | host | sub-CPU | 12 | PIO; DBC not used, always 12 bytes |
| 1 | 0 | 1 | sub-CPU | host | 12 | DMA and PIO |
| 1 | 1 | x | reserved | reserved | reserved | – |

In the Sanyo and Oak compatibility modes the only transfers are memory-to-host, host-to-memory, sub-CPU-to-memory, and memory-to-sub-CPU. Setting the TRANT bits to any other settings while in these host modes will cause undefined results.

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7.8 Sub-CPU interface

The sub-CPU interface is a 3-wire synchronous serial protocol. The interface uses three signals; SYN is used as a synchronization signal, SDA is the bidirectional open-collector data signal and SCL is the bit clock.

The start of a command is signalled by a pulse on the SYN input. After this pulse an 8-bit address byte will be sent by the sub-CPU. The format of this address byte is given in Table 24.

Table 24 Address byte format

| BIT | NAME | DESCRIPTION |
|-----|-------------------|---|
| 7 | device select | If this bit is clear then the command will be for the SAA7388 otherwise the command is for another device and the SAA7388 will not respond. |
| 6 | address mode | This bit controls the auto-increment function. After every byte has been read from or written to the SAA7388 the address register is updated so that it is not necessary to re-send the address to read or write the following byte. The way the address register is updated is determined by the address mode bit. If the address mode bit is logic 0 then the address register will increment by 1 if it is currently in the range 1 to 14 or 16 to 30. If the address register is currently 15 or 31 then it will update to 0, if the address register is at logic 0 then it will remain at address 0. If the address mode bit is logic 1 then the address register will update in the following sequences; Read: APCMD/COMIN -> APCMD/COMIN, IFSTAT -> DBCL -> DBCH -> HEAD0 -> HEAD1 -> HEAD2 -> HEAD3 -> PTL -> PTH -> PTHH -> WAL -> WAH -> WAHH -> STAT0 -> STAT1 -> STAT2 -> STAT3 -> APCMD/COMIN, ACMD -> ASMAT -> ADCTR -> ADRSEL -> AINTR -> AFEAT -> APCMD/COMIN. Write: ADATA/SBOUT -> ADATA/SBOUT, IFCTRL -> DBCL -> DBCH -> DACL -> DACH -> DACHH -> DTRG -> DTACK -> WAL -> WAH -> WAHH -> CTRL0 -> CTRL1 -> PTL -> PTH -> PTHH -> SUB_L -> SUB_H -> 21 -> INCNF -> MEMS -> ASTAT -> ITRG -> ADRADR -> ASAMT -> DTCTR -> ADRSEL -> AINTR -> AERR -> ADATA/SBOUT. |
| 5 | register number | This is the address that is loaded into the address register and determines which register is accessed. |
| 4 | | |
| 3 | | |
| 2 | | |
| 1 | | |
| 0 | R/ \overline{W} | If this bit is set to logic 0 then the sub-CPU will send one or more data bytes after the address byte. This data will be loaded into the specified registers. If this bit is set to logic 1 then after sending the address byte the sub-CPU will clock out the contents of one or more registers. |

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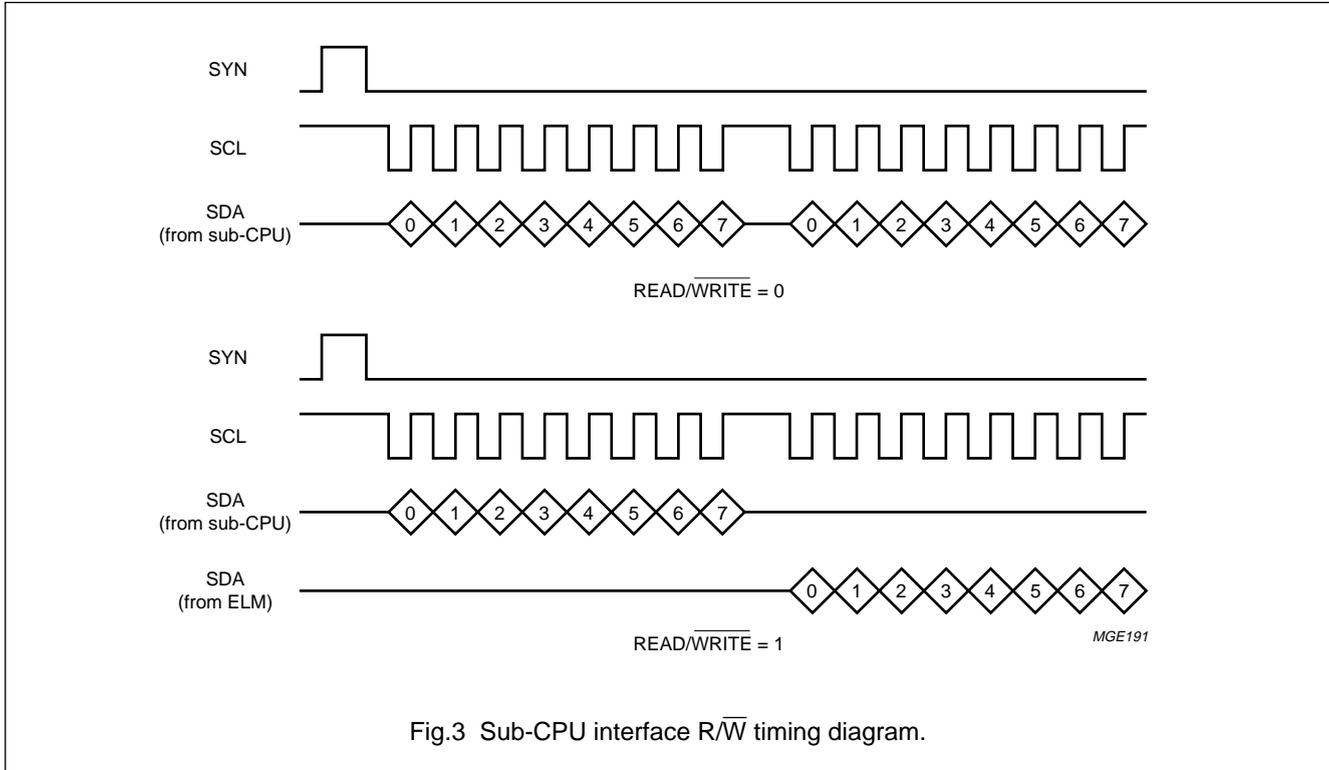


Fig.3 Sub-CPU interface R/W timing diagram.

7.9 Host registers

7.9.1 SANYO COMPATIBILITY MODE

Table 25 Sanyo compatibility mode

| $\overline{\text{HEN}}$ | CMD | $\overline{\text{HRD}}$ | $\overline{\text{HWR}}$ | OPERATION |
|-------------------------|------------|-------------------------|-------------------------|------------------|
| 0 | 0 | 1 | 0 | write COMIN |
| 0 | 0 | 0 | 1 | read SBOUT |
| 0 | 1 | 1 | 0 | write data |
| 0 | 1 | 0 | 1 | read data |
| 1 | X | X | X | none (note 1) |

Note

1. Where X = don't care.

7.9.1.1 COMIN

This is a 12-byte FIFO used for sending commands from the host to the sub-CPU. When the host writes to the COMIN register a sub-CPU CMDI interrupt is generated to indicate there are bytes in the COMIN FIFO. This is cleared when the sub-CPU empties the FIFO. If the host writes to the register when the FIFO is full then the command is ignored.

If the host writes to this register when the CMDBK bit in the IFCTRL register is asserted then this will terminate any data or status byte transfers that are in progress.

7.9.1.2 SBOUT

This is a 12 byte FIFO used to transfer status bytes from the sub-CPU to the host. The host should only access this register when the STEN pin is LOW indicating that there are status bytes available.

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7.9.1.3 Data Transfer

The other registers are used for data transfers. These can only occur when the sub-CPU has enabled a data transfer. This will be indicated to the host by the $\overline{\text{DTEN}}$ pin being LOW.

7.9.2 OAK COMPATIBILITY MODE

Table 26 Oak compatibility mode

| DMACK | $\overline{\text{HEN}}^{(1)}$ | DA1 ⁽¹⁾ | $\overline{\text{DA0}}^{(1)}$ | $\overline{\text{HRD}}^{(1)}$ | $\overline{\text{HWR}}^{(1)}$ | DATA TRANSFER SELECTED ⁽¹⁾ | OPERATION |
|-------|-------------------------------|--------------------|-------------------------------|-------------------------------|-------------------------------|--|-----------------------------------|
| 1 | 0 | 0 | 0 | 1 | 0 | NO | write COMIN |
| 1 | 0 | 0 | 0 | 0 | 1 | NO | read SBOUT |
| 1 | 0 | 0 | 0 | 1 | 0 | YES | write data |
| 1 | 0 | 0 | 0 | 0 | 1 | YES | read data |
| 1 | 0 | 0 | 1 | 1 | 0 | X | $\overline{\text{RESET}}$ sub-CPU |
| 1 | 0 | 0 | 1 | 0 | 1 | X | read TSTAT |
| 1 | 0 | 1 | 0 | 1 | 0 | X | write HCON |
| 1 | 1 | X | X | X | X | X | none |
| 0 | X | X | X | 1 | 0 | X | write DMA data |
| 0 | X | X | X | 0 | 1 | X | read DMA data |

Note

1. Where X = don't care.

Data transfer is selected when the transfer type is non-DMA, the sub-CPU has started a data transfer and the DTS bit in the HCON register has not been asserted.

DMA transfer is selected using the HCON register.

The COMIN and SBOUT registers are similar to the same registers in the Sanyo compatibility mode.

7.9.2.1 $\overline{\text{RESET}}$ Sub-CPU

Writing to this register causes the $\overline{\text{SCRST}}$ pin to go LOW for several clock periods. The SAA7388 registers are not affected.

7.9.2.2 TSTAT

Table 27 TSTAT register bits

| BIT 7 | BIT 6 | BIT 5 | BIT 4 | BIT 3 | BIT 2 | BIT 1 | BIT 0 |
|-------|-------|-------|--------------------------|-------------------------|--------------------------|--------------------------|-------|
| 1 | 1 | EJECT | $\overline{\text{WAIT}}$ | $\overline{\text{EOP}}$ | $\overline{\text{STEN}}$ | $\overline{\text{DTEN}}$ | DRQ |

This is the host Transfer Status Register. The EJECT bit reflects the state of the EJECT pin. Bits $\overline{\text{EOP}}$, $\overline{\text{STEN}}$ and $\overline{\text{DTEN}}$ have the same operation as the equivalent pins in the Sanyo compatibility mode. Bit $\overline{\text{WAIT}}$ is the same as the Sanyo mode $\overline{\text{WAIT}}$ pin when non-DMA transfer is selected otherwise it is logic 1. Bit DRQ is the same as the Sanyo mode $\overline{\text{WAIT}}$ pin when DMA transfer is selected otherwise it is logic 0.

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7.9.2.3 HCON

Table 28 HCON register bits

| BIT 7 ⁽¹⁾ | BIT 6 ⁽¹⁾ | BIT 5 ⁽¹⁾ | BIT 4 ⁽¹⁾ | BIT 3 | BIT 2 | BIT 1 | BIT 0 |
|----------------------|----------------------|----------------------|----------------------|-------|-------|-------|-------|
| X | X | X | X | DTS | SDRQ | LOHI | DMA16 |

Note

- Where X = don't care.

This is the host configuration register. Resetting SAA7388 clears this register.

Bit DTS is the suspend transfer bit. Setting this bit HIGH suspends non-DMA transfers and allows the host to access the COMIN and SBOU registers. During DMA transfers this bit has no effect.

If SDRQ is LOW and the SELRQ pin is LOW then DMA transfer is selected otherwise non-DMA transfer is selected.

The pseudo 16-bit DMA read transfer is selected by setting bit DMA16 HIGH. DMA transfer must also be selected for this mode to operate. host writes are always 8-bit and are not affected by this bit.

The LOHI bit when HIGH causes the pseudo 16-bit DMA transfer to be a LOW byte followed by a HIGH byte. Setting it LOW causes the sequence to be a HIGH byte followed by a LOW byte. If the 16-bit DMA mode is not selected then this bit has no effect.

7.9.3 ATAPI MODE

The following registers are accessible by the ATAPI host. Most of these registers are identical to the sub-CPU registers with the same name.

Table 29 ATAPI registers

| ADDRESS | | | | | WRITE \overline{HWR} | READ \overline{HRD} | WIDTH |
|---------|------------------|-----|-----|------------------|------------------------|-----------------------|-------|
| CS2 | $\overline{CS1}$ | DA2 | DA1 | $\overline{DA0}$ | | | |
| 1 | 0 | 0 | 0 | 0 | DATA | DATA | 16 |
| 1 | 0 | 0 | 0 | 1 | AFEAT | AERR | 8 |
| 1 | 0 | 0 | 1 | 0 | AINTR | AINTR | 8 |
| 1 | 0 | 0 | 1 | 1 | ASAMT | ASAMT | 8 |
| 1 | 0 | 1 | 0 | 0 | DBCL | DBCL | 8 |
| 1 | 0 | 1 | 0 | 1 | DBCH | DBCH | 8 |
| 1 | 0 | 1 | 1 | 0 | ADRSEL | ADRSEL | 8 |
| 1 | 0 | 1 | 1 | 1 | ACMD | ASTAT | 8 |
| 0 | 1 | 1 | 1 | 0 | ADCTR | Alt Status | 8 |
| 0 | 1 | 1 | 1 | 1 | reserved | ADRADR | 8 |

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Table 30 Description of registers

| REGISTER | DESCRIPTION |
|---------------|---|
| DATA | This is a 16-bit register and is used for transferring data to and from the host. This should only be performed after the Sub-CPU has initiated the data transfer. |
| AFEAT | This is the ATAPI Features register. |
| AERR | This is the ATAPI Error register. |
| AINTR | This is the ATAPI Interrupt Reason register. |
| ASAMT | This is the ATAPI Sector Count register. |
| DBCL and DBCH | These are the ATAPI Byte Count registers. |
| ADRSEL | This is the ATAPI Drive Select register (see Table 31). Bit 4 of this register is the DRV bit. When this bit is the same as the RDRV bit in the DTCTR register then SAA7388 will be the selected ATAPI drive and will respond to commands and produce interrupts. The host Interrupt pin will also be enabled when SAA7388 is the selected drive. |
| ACMD | This is the ATAPI Command register. A CMDI interrupt is generated when the host writes to this register while SAA7388 is the selected drive (the DRV bit in ADRSEL is equal to the RDRV bit in DTCTR) and when the host writes the execute drive diagnostic command (90H) to this register. If a host interrupt is asserted then it will be cleared by writing to this register. |
| ASTAT | This is the ATAPI Status register. Bit-7 is the BSY bit and this will be set whenever the host writes to the ACMD register and SAA7388 is the selected drive, when the host writes the execute drive diagnostic command (90H) to the ACMD register, when the host writes to the ADCTR register and sets the SRST bit and when there is a hardware reset. If a host interrupt is asserted then it will be cleared by writing to this register. |
| ALT STATUS | This is the ATAPI Alternative Status register. This is identical to the ASTAT register except reading this register does not negate the host interrupt. |
| ADCTR | This is the ATAPI Device Control register (see Table 32) |
| ADRADR | This is the ATAPI Drive Address register. Bit 7 of this register is high impedance. |

Table 31 ADRSEL register bits

| BIT 7 | BIT 6 | BIT 5 | BIT 4 | BIT 3 | BIT 2 | BIT 1 | BIT 0 |
|-------|-------|-------|-------|-------|-------|-------|-------|
| 1 | 1 | 1 | DRV | – | – | – | – |

Table 32 ADCTR register bits

| BIT 7 | BIT 6 | BIT 5 | BIT 4 | BIT 3 | BIT 2 | BIT 1 | BIT 0 |
|----------|-------|-------|-------|-------|-------|-------|-------|
| reserved | | | | 1 | SRST | nIEN | 0 |

Setting the SRST bit HIGH causes a SRSTI interrupt and the BSY bit to be set.

Bit nIEN is used to enable or disable the host interrupt. When nIEN is logic 0 and the drive is selected then the host interrupt pin will be enabled. If nIEN is logic 1 or the drive is not selected then the host interrupt pin will be in a high-impedance state.

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7.10 CD-DSP Timings

The timings are for 8 times speed with a 33 MHz crystal.

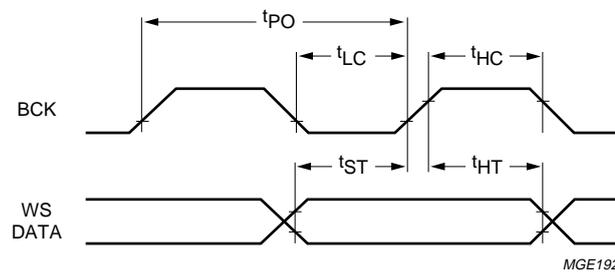


Fig.4 CD-DSP Interface Timing.

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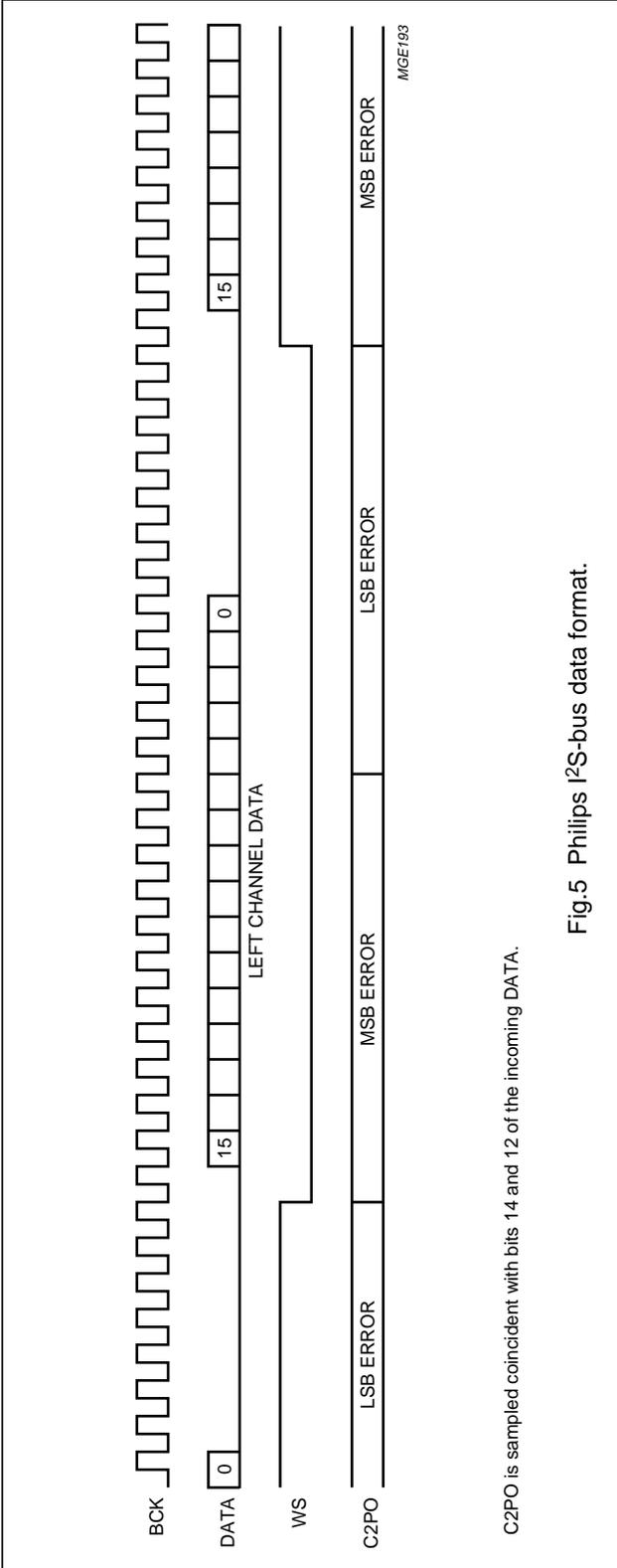


Fig.5 Philips I²S-bus data format.

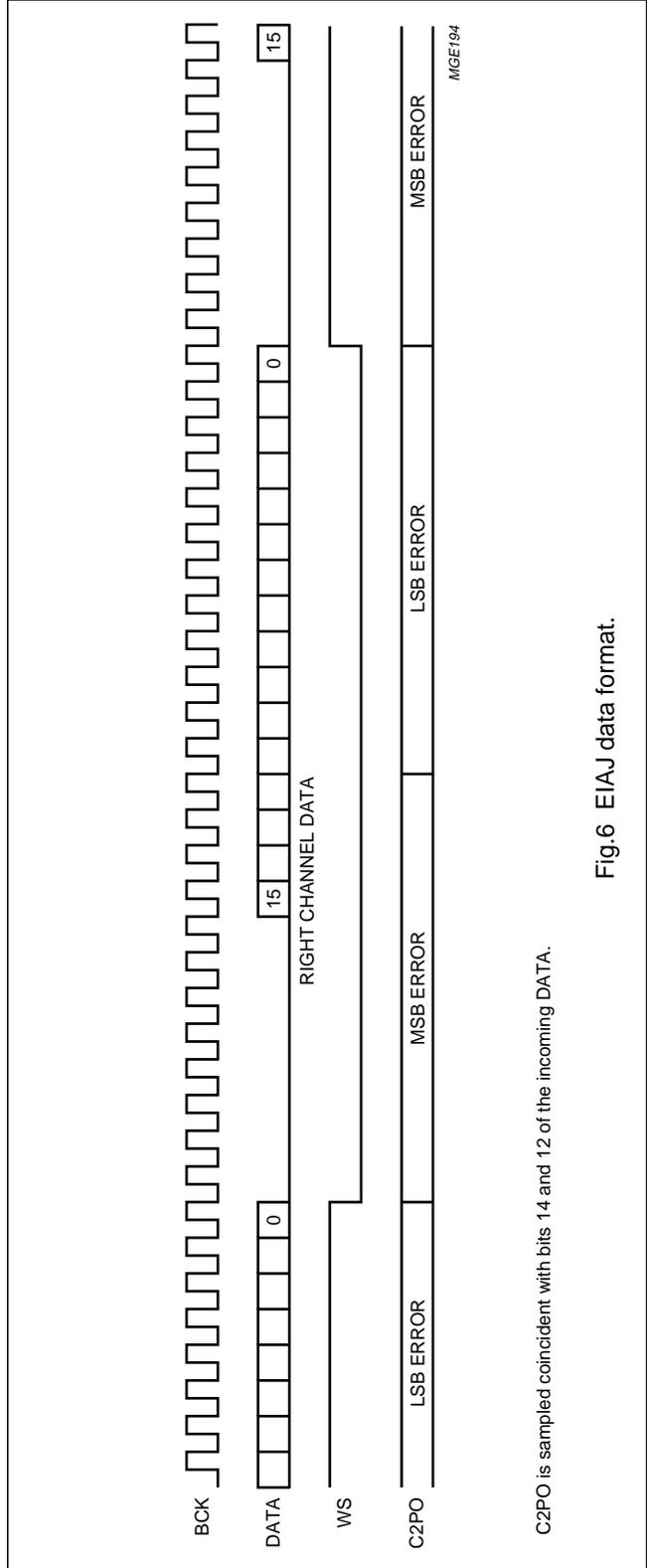


Fig.6 EIAJ data format.

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8 LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 134).

| SYMBOL | PARAMETER | CONDITIONS | MIN. | MAX. | UNIT |
|---------------------|-------------------------------------|------------|------|------------------------|------|
| V _{DDD1} | digital supply voltage 1 | note 1 | -0.5 | +4.5 | V |
| V _{DDD2} | digital supply voltage 2 | note 1 | -0.5 | +6.5 | V |
| V _{I(max)} | maximum input voltage on any input | | -0.5 | V _{DDD} + 0.5 | V |
| V _O | output voltage on any output | | -0.5 | +6.5 | V |
| I _O | output current (continuous) | | - | 20 | mA |
| I _{IK} | DC input diode current (continuous) | | - | 20 | mA |
| P _{diss} | power dissipation | | - | 400 | mW |
| T _{stg} | storage temperature | | -55 | +125 | °C |
| T _{amb} | operating ambient temperature | | 0 | +70 | °C |

Note

1. All V_{DD} and V_{SS} connections must be made externally to the same associated power supply.

9 THERMAL CHARACTERISTICS

| SYMBOL | DESCRIPTION | VALUE | UNIT |
|--------------------|---|-------|------|
| R _{thj-a} | thermal resistance from junction to ambient in free air | 55 | K/W |

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10 CHARACTERISTICS

$V_{DDD1} = 3.0$ to 3.6 V; $V_{DDD2} = 4.5$ to 5.5 V; $V_{SSD} = 0$; $T_{amb} = 0$ to 70 °C; unless otherwise stated.

| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|---|---------------------------------------|---|------------------|----------------|------------------|---------------|
| Supply | | | | | | |
| V_{DDD1} | digital supply voltage 1 | | 3.0 | 3.3 | 3.6 | V |
| V_{DDD2} | digital supply voltage 2 | | 4.5 | 5.0 | 5.5 | V |
| I_{DDD} | supply current | $V_{DDD1} = 3.3$ V; $V_{DDD2} = 5$ V | – | 60 | – | mA |
| I_{DDDq} | quiescent supply current | $V_{DDD1} = 3.3$ V; $V_{DDD2} = 5$ V | – | 100 | – | mA |
| Digital inputs | | | | | | |
| INPUT: $\overline{\text{RESET}}$ (CMOS INPUT) | | | | | | |
| $V_{th(r)}$ | switching threshold rising | | – | – | $0.8V_{DDD2}$ | V |
| $V_{th(f)}$ | switching threshold falling | | $0.2V_{DDD2}$ | – | – | V |
| V_{hys} | hysteresis voltage | | – | $0.33V_{DDD2}$ | – | V |
| C_i | input capacitance | | – | – | 10 | pF |
| t_{RW} | $\overline{\text{RESET}}$ pulse width | $\overline{\text{RESET}}$ only | 1 | – | – | μs |
| INPUTS: SFSY, SUB, BCK, WS, DATA, C2PO, SCL, $\overline{\text{CS1/HEN}}$, HWR, HRD, DA0/CMD, DMACK/SELRQ, DA1, DA2/EJECT, CS2 AND SYN (CMOS INPUT) | | | | | | |
| V_{IL} | LOW level input voltage | | –0.3 | – | $0.3V_{DDD2}$ | V |
| V_{IH} | HIGH level input voltage | | $0.7V_{DDD2}$ | – | $V_{DDD2} + 0.3$ | V |
| I_{LI} | input leakage current | $V_i = 0 - V_{DDD2}$ | –10 | – | +10 | μA |
| C_i | input capacitance | | – | – | 10 | pF |
| INPUTS: TEST1 AND TEST2 (CMOS INPUT) | | | | | | |
| V_{IL} | LOW level input voltage | | –0.3 | – | $0.3V_{DDD2}$ | V |
| V_{IH} | HIGH level input voltage | | $0.7V_{DDD2}$ | – | $V_{DDD2} + 0.3$ | V |
| R_{pd} | input pull-down resistance | $V_i = V_{DDD2}$ | – | 50 | – | k Ω |
| C_i | input capacitance | | – | – | 10 | pF |
| Digital outputs | | | | | | |
| OUTPUTS: RA0, RA1 TO RA14, RA15/RAS, RA16/CAS, RWE, $\overline{\text{RCK}}$ AND $\overline{\text{SCRST/STEN}}$ | | | | | | |
| V_{OL} | LOW level output voltage | $I_{OL} = 1$ mA | 0 | – | 0.4 | V |
| V_{OH} | HIGH level output voltage | $I_{OH} = -1$ mA | $V_{DDD2} - 0.4$ | – | V_{DDD2} | V |
| C_L | load capacitance | | – | – | 25 | pF |
| t_r | output rise time | $C_L = 20$ pF; 0.8 to $(V_{DDD2} - 0.8)$ | – | – | 10 | ns |
| t_f | output fall time | $C_L = 20$ pF; $(V_{DDD2} - 0.8)$ to 0.8 | – | – | 10 | ns |

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| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|--|---------------------------|---|-------------------------|------|-------------------------|------|
| OPEN-DRAIN OUTPUTS; INT, IOCS16 | | | | | | |
| V _{OL} | LOW level output voltage | V _{DDD2} = 4.5 to 5.5 V; I _{OL} = 1 mA | 0 | – | 0.4 | V |
| I _{OL} | LOW level output current | | – | – | 2 | mA |
| C _L | load capacitance | | – | – | 25 | pF |
| t _f | output fall time | C _L = 20 pF; 0.8 – (V _{DDD2} – 0.8) | – | – | 20 | ns |
| 3-state outputs | | | | | | |
| OUTPUTS: $\overline{\text{IRQ/EOP/HFBC}}$, $\overline{\text{IRDY/WAIT/HFBLB}}$ AND $\overline{\text{DMARQ/DTEN}}$ | | | | | | |
| V _{OL} | LOW level output voltage | I _{OL} = 1 mA | 0 | – | 0.4 | V |
| V _{OH} | HIGH level output voltage | I _{OH} = –1 mA | V _{DDD2} – 0.4 | – | V _{DDD2} | V |
| C _L | load capacitance | | – | – | 50 | pF |
| t _r | output rise time | C _L = 20 pF; 0.8 – (V _{DDD2} – 0.8) | – | – | 15 | ns |
| t _f | output fall time | C _L = 20 pF; (V _{DDD2} – 0.8) – 0.8 | – | – | 15 | ns |
| I _{LZ} | 3-state leakage current | V _i = 0 – V _{DDD2} | –10 | – | +10 | μA |
| Digital inputs/outputs | | | | | | |
| INPUTS AND OUTPUTS: RD0 TO RD7 | | | | | | |
| V _{OL} | LOW level output voltage | I _{OL} = 1 mA | 0 | – | 0.4 | V |
| V _{OH} | HIGH level output voltage | I _{OH} = –1 mA | V _{DDD2} – 0.4 | – | V _{DDD2} | V |
| V _{IL} | LOW level input voltage | | –0.3 | – | 0.3V _{DDD2} | V |
| V _{IH} | HIGH level input voltage | | 0.7V _{DDD2} | – | V _{DDD2} + 0.3 | V |
| C _L | load capacitance | | – | – | 50 | pF |
| t _r | output rise time | C _L = 20 pF; 0.8 – (V _{DDD2} – 0.8) | – | – | 15 | ns |
| t _f | output fall time | C _L = 20 pF; (V _{DDD2} – 0.8) – 0.8 | – | – | 15 | ns |
| I _{LZ} | 3-state leakage current | V _i = 0 – V _{DDD2} | –10 | – | +10 | μA |
| INPUTS AND OUTPUTS: HD0 TO HD15 | | | | | | |
| V _{OL} | LOW level output voltage | I _{OL} = 1 mA | 0 | – | 0.4 | V |
| V _{OH} | HIGH level output voltage | I _{OH} = –1 mA | V _{DDD2} – 0.4 | – | V _{DDD2} | V |
| V _{IL} | LOW level input voltage | | –0.3 | – | 0.3V _{DDD2} | V |
| V _{IH} | HIGH level input voltage | | 0.7V _{DDD2} | – | V _{DDD2} + 0.3 | V |
| C _L | load capacitance | | – | – | 100 | pF |
| t _r | output rise time | C _L = 20 pF; 0.8 – (V _{DDD2} – 0.8) | – | – | 5 | ns |
| t _f | output fall time | C _L = 20 pF; (V _{DDD2} – 0.8) – 0.8 | – | – | 5 | ns |
| I _{LZ} | 3-state leakage current | V _i = 0 – V _{DDD2} | –10 | – | +10 | μA |

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| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|-------------------------------------|--------------------------------|---|-----------------|------|-----------------|------------------|
| INPUT AND OUTPUT: SDA | | | | | | |
| V_{IL} | LOW level input voltage | | -0.3 | - | $0.3V_{DD2}$ | V |
| V_{IH} | HIGH level input voltage | | $0.7V_{DD2}$ | - | $V_{DD2} + 0.3$ | V |
| I_{LZ} | 3-state leakage current | $V_i = 0 - V_{DD2}$ | -10 | - | +10 | μA |
| C_i | input capacitance | | - | - | 10 | pF |
| V_{OL} | LOW level output voltage | $I_{OL} = 1 \text{ mA}$ | 0 | - | 0.4 | V |
| V_{OH} | HIGH level output voltage | $I_{OH} = -1 \text{ mA}$ | $V_{DD2} - 0.4$ | - | V_{DD2} | V |
| I_{OL} | LOW level output current | | - | - | 4 | mA |
| C_L | load capacitance | | - | - | 100 | pF |
| t_r | output rise time | $C_L = 25 \text{ pF};$ $0.8 - (V_{DD2} - 0.8)$ | - | - | 5 | ns |
| t_f | output fall time | $C_L = 25 \text{ pF};$ $(V_{DD2} - 0.8) - 0.8$ | - | - | 5 | ns |
| Crystal oscillator | | | | | | |
| INPUT: CRIN (EXTERNAL CLOCK) | | | | | | |
| I_{LI} | input leakage current | | -10 | - | +10 | μA |
| C_i | input capacitance | | - | - | 10 | pF |
| OUTPUT: CROUT | | | | | | |
| f_{xtal} | crystal frequency | | 15.2 | 48 | 50.4 | MHz |
| g_m | mutual conductance at start-up | | - | 4 | - | mA/V |
| R_O | output resistance at start-up | | - | 11 | - | $\text{k}\Omega$ |
| C_{fb} | feedback capacitance | | - | - | 5 | pF |
| C_o | output capacitance | | - | - | 10 | pF |

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11 TIMING CHARACTERISTICS

| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|---|---------------------|------------|------|------|------|---------|
| CD-DSP timing; see Figs 4, 5 and 6; note 1 | | | | | | |
| INPUT: BCK | | | | | | |
| t_{PO} | input clock period | | 40 | – | 1050 | ns |
| t_{HC} | clock HIGH time | | 14 | – | – | ns |
| t_{LC} | clock LOW time | | 14 | – | – | ns |
| INPUTS: WS AND DATA | | | | | | |
| t_{ST} | set-up time | | 8 | – | – | ns |
| t_{HT} | hold time | | 0 | – | – | ns |
| Q-to-W subcode timing; see Figs 7 and 8; note 1 | | | | | | |
| INPUT: SFSY | | | | | | |
| t_{FW} | sync pulse width | | 244 | 272 | 800 | μ s |
| t_F | frame cycle | | 122 | 136 | 150 | μ s |
| t_{LW} | LOW level period | | 1.5 | 68 | – | μ s |
| t_{HW} | HIGH level period | | 4 | 68 | – | μ s |
| OUTPUT: \overline{RCK} | | | | | | |
| t_{CD} | output delay time | | 5 | 20 | 30 | μ s |
| t_{HPW} | HIGH level period | | 0.6 | 4 | 6 | μ s |
| t_{LPW} | LOW level period | | 2 | 4 | 9 | μ s |
| INPUT: SUB | | | | | | |
| t_{HD} | data hold time | | 0 | – | – | μ s |
| t_{AC} | data access time | | – | – | 0.8 | μ s |
| t_{PAC} | P data access time | | – | 2 | 4 | μ s |
| SRAM interface timing; see Figs 9 and 10; note 2 | | | | | | |
| t_{RC} | read cycle period | | 6T | – | – | ns |
| t_{DS} | data set-up time | | 30 | – | – | ns |
| t_{DH} | data hold time | | 5 | – | – | ns |
| t_{WC} | write cycle time | | 6T | – | – | ns |
| t_{WP} | write pulse time | | 2T | – | – | ns |
| t_{AS} | address set-up time | | T | – | – | ns |
| t_{WR} | write recovery time | | T | – | – | ns |
| t_{DO} | data output time | | – | – | 30 | ns |

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| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|--|--|-------------|---------|------|---------|------|
| DRAM interface timing; see Figs 11 and 12; note 2 | | | | | | |
| t _{RC} | read or write cycle period | | 10T | – | – | ns |
| t _{PC} | page mode cycle time | | 4T | – | – | ns |
| t _{CAC} | access time from CAS | | – | – | 3T – 10 | ns |
| t _{RAC} | access time from RAS | | – | – | 7T – 10 | ns |
| t _{OFF} | output disable time from CAS | | 0 | – | – | ns |
| t _{RHCP} | RAS hold time from CAS precharge page mode | | 4T | – | – | ns |
| t _{CAA} | column address access | | – | – | 4T | ns |
| t _{RP} | RAS HIGH time | | 4T | – | – | ns |
| t _{RAS} | RAS LOW time | | 6T | – | – | ns |
| t _{RSH} | RAS hold time | | 4T – 10 | – | – | ns |
| t _{CAS} | CAS LOW time | | 3T | – | – | ns |
| t _{CSH} | CAS hold time | | 7T – 10 | – | – | ns |
| t _{CP} | CAS HIGH pulse width | | T | – | – | ns |
| t _{CRP} | delay CAS HIGH to RAS | | 3T – 10 | – | – | ns |
| t _{RCD} | RAS to CAS delay time | | 2T | – | – | ns |
| t _{RAD} | RAS to column address delay | | T | – | – | ns |
| t _{ASR} | row address set-up time | | 3T – 10 | – | – | ns |
| t _{RAH} | row address hold time | | T | – | – | ns |
| t _{ASC} | column address set-up time | | T | – | – | ns |
| t _{CAH} | column address hold time | | 3T – 10 | – | – | ns |
| t _{AR} | column address hold time from RAS LOW | | 5T – 10 | – | – | ns |
| t _{RAL} | column address to RAS lead | | 3T | – | – | ns |
| t _{RCS} | read set-up time before CAS | | 4T – 10 | – | – | ns |
| t _{RCH} | read command hold time | | T | – | – | ns |
| t _{RRH} | read command hold time from RAS | | 2T – 10 | – | – | ns |
| t _{WCH} | write command hold time | | 6T – 10 | – | – | ns |
| t _{WP} | write command LOW time | | 10T | – | – | ns |
| t _{WCR} | write command hold time from RAS | | 8T – 10 | – | – | ns |
| t _{CWL} | write command to CAS lead | | 9T – 10 | – | – | ns |
| t _{RWL} | write command to RAS lead | | 8T – 10 | – | – | ns |
| t _{DS} | data output set-up time | | T | – | – | ns |
| t _{DH} | data output hold time | | 3T | – | – | ns |
| t _{DHR} | data output hold from RAS | | 7T – 10 | – | – | ns |
| t _{RFSH} | refresh cycle time | MEMS(3) = 0 | – | – | 400T | ns |
| | | MEMS(3) = 1 | – | – | 800T | ns |
| t _{CSR} | CAS set-up time for refresh | | 2T – 10 | – | – | ns |
| t _{CHR} | CAS hold time for refresh | | 6T – 10 | – | – | ns |
| t _{RPC} | precharge to CAS active time | | T | – | – | ns |

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| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|--|---|---|------|------|------|------|
| Sub-CPU timing; see Fig.13 | | | | | | |
| t ₀ | syn to first SCL | | 250 | – | – | ns |
| t ₁ | SCL cycle time | | 500 | – | – | ns |
| t ₂ | time between bytes | | 250 | – | – | ns |
| t ₃ | data set-up | | 150 | – | – | ns |
| t ₄ | data hold | | 0 | – | – | ns |
| t ₅ | data access | | – | – | 150 | ns |
| ATAPI host interface timing; see Fig.14 | | | | | | |
| PIO 8 AND 16-BIT TRANSFER | | | | | | |
| t ₀ | cycle time | 33 MHz clock | 150 | – | – | ns |
| | | 16 MHz clock | 240 | – | – | ns |
| t ₁ | address to $\overline{\text{HWR}}/\overline{\text{HRD}}$ set-up | | 30 | – | – | ns |
| t ₂ | $\overline{\text{HWR}}/\overline{\text{HRD}}$ active | 33 MHz clock | 80 | – | – | ns |
| | | 16 MHz clock | 100 | – | – | ns |
| t _{2i} | $\overline{\text{HWR}}/\overline{\text{HRD}}$ inactive | 33 MHz clock | 70 | – | – | ns |
| | | 16 MHz clock | 140 | – | – | ns |
| t ₃ | $\overline{\text{HWR}}$ data set-up | | 30 | – | – | ns |
| t ₄ | $\overline{\text{HWR}}$ data hold | | 10 | – | – | ns |
| t ₅ | $\overline{\text{HRD}}$ data set-up | | 50 | – | – | ns |
| t ₆ | $\overline{\text{HRD}}$ data 3-state | | – | – | 30 | ns |
| t ₇ | address to IOCS16 | only for 16-bit data register | – | – | 30 | ns |
| t ₈ | address to IOCS16 negate | only for 16-bit data register | – | – | 30 | ns |
| t ₉ | $\overline{\text{HWR}}/\overline{\text{HRD}}$ to address hold | | 10 | – | – | ns |
| t ₁₀ | $\overline{\text{IORDY}}$ set-up | | – | – | 35 | ns |
| t ₁₁ | $\overline{\text{IORDY}}$ width | only if $\overline{\text{IORDY}}$ negated | – | – | 1250 | ns |
| t ₁₂ | read data valid to $\overline{\text{IORDY}}$ active | only if $\overline{\text{IORDY}}$ negated | 0 | – | – | ns |
| SINGLE-WORD DMA TRANSFER; see Fig.15 | | | | | | |
| t ₀ | cycle time | 33 MHz clock | 240 | – | – | ns |
| | | 16 MHz clock | 480 | – | – | ns |
| t ₁ | DMACK to $\overline{\text{DMARQ}}$ | | – | – | 80 | ns |
| t ₂ | DMACK to $\overline{\text{HWR}}/\overline{\text{HRD}}$ | | 0 | – | – | ns |
| t ₃ | $\overline{\text{HWR}}/\overline{\text{HRD}}$ active | 33 MHz clock | 120 | – | – | ns |
| | | 16 MHz clock | 240 | – | – | ns |
| t ₄ | $\overline{\text{HWR}}/\overline{\text{HRD}}$ to DMACK hold | | 0 | – | – | ns |
| t ₅ | $\overline{\text{HWR}}$ data set-up | | 35 | – | – | ns |
| t ₆ | $\overline{\text{HWR}}$ data hold | | 20 | – | – | ns |
| t ₇ | $\overline{\text{HRD}}$ data access | | – | – | 60 | ns |
| t ₈ | $\overline{\text{HRD}}$ data hold | | 5 | – | – | ns |

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| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|---|---|---------------------------------------|------|------|------|------|
| MULTI-WORD DMA TRANSFER; see Fig.16; note 3 | | | | | | |
| t ₀ | cycle time | | 130 | – | – | ns |
| t ₁ | $\overline{\text{HWR}}/\overline{\text{HRD}}$ to $\overline{\text{DMARQ}}$ inactive | | – | – | 40 | ns |
| t ₂ | $\overline{\text{DMACK}}$ to $\overline{\text{HWR}}/\overline{\text{HRD}}$ | | 0 | – | – | ns |
| t ₃ | $\overline{\text{HWR}}/\overline{\text{HRD}}$ active | | 80 | – | – | ns |
| t ₄ | $\overline{\text{HWR}}/\overline{\text{HRD}}$ inactive | | 50 | – | – | ns |
| t ₅ | $\overline{\text{HWR}}/\overline{\text{HRD}}$ to $\overline{\text{DMACK}}$ hold | | 5 | – | – | ns |
| t ₆ | $\overline{\text{HWR}}$ data set-up | | 30 | – | – | ns |
| t ₇ | $\overline{\text{HWR}}$ data hold | | 15 | – | – | ns |
| t ₈ | $\overline{\text{HRD}}$ data access | | – | – | 60 | ns |
| t ₉ | $\overline{\text{HRD}}$ data hold | | 5 | – | – | ns |
| t ₁₀ | $\overline{\text{DMACK}}$ inactive to read data 3-state | | – | – | 25 | ns |
| Sanyo compatibility mode host interface timing; see Fig.17 | | | | | | |
| COMIN AND SBOU ACCESS | | | | | | |
| t ₀ | $\overline{\text{HEN}}$ set-up | | 30 | – | – | ns |
| t ₁ | $\overline{\text{HEN}}$ hold | | 0 | – | – | ns |
| t ₂ | $\overline{\text{CMD}}$ set-up | | 15 | – | – | ns |
| t ₃ | $\overline{\text{CMD}}$ hold | | 5 | – | – | ns |
| t ₄ | $\overline{\text{HWR}}/\overline{\text{HRD}}$ active | 33 MHz clock | 50 | – | – | ns |
| | | 16 MHz clock | 75 | – | – | ns |
| t ₅ | $\overline{\text{HWR}}/\overline{\text{HRD}}$ data inactive | 33 MHz clock | 60 | – | – | ns |
| | | 16 MHz clock | 145 | – | – | ns |
| t ₆ | $\overline{\text{HWR}}$ data set-up | | 50 | – | – | ns |
| t ₇ | $\overline{\text{HWR}}$ data hold | | 20 | – | – | ns |
| t ₈ | $\overline{\text{HRD}}$ data access | | – | – | 80 | ns |
| t ₉ | $\overline{\text{HRD}}$ data to 3-state | | 5 | – | 60 | ns |
| t ₁₀ | $\overline{\text{STEN}}$ to $\overline{\text{HRD}}$ | only for SBOU read | 0 | – | – | ns |
| t ₁₁ | $\overline{\text{HRD}}$ to $\overline{\text{STEN}}$ inactive | for last SBOU read; 33 MHz clock | – | – | 100 | ns |
| | | 16 MHz clock | – | – | 145 | ns |
| t ₁₂ | $\overline{\text{HWR}}$ to $\overline{\text{DTEN}}/\overline{\text{STEN}}$ inactive | only for COMIN write when CMBK = 0 | – | – | 100 | ns |

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| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|--|--|--|------|------|------|------|
| WAIT CONTROL DATA TRANSFER; see Fig.18 | | | | | | |
| t ₀ | $\overline{\text{HEN}}$ set-up | | 30 | – | – | ns |
| t ₁ | $\overline{\text{HEN}}$ hold | | 0 | – | – | ns |
| t ₂ | CMD set-up | | 15 | – | – | ns |
| t ₃ | CMD hold | | 5 | – | – | ns |
| t ₄ | $\overline{\text{HWR}}/\overline{\text{HRD}}$ active | 33 MHz clock | 50 | – | – | ns |
| | | 16 MHz clock | 75 | – | – | ns |
| t ₅ | $\overline{\text{HWR}}/\overline{\text{HRD}}$ inactive | 33 MHz clock | 60 | – | – | ns |
| | | 16 MHz clock | 145 | – | – | ns |
| t ₆ | $\overline{\text{HWR}}$ data set-up | | 50 | – | – | ns |
| t ₇ | $\overline{\text{HWR}}$ data hold | | 20 | – | – | ns |
| t ₈ | $\overline{\text{HRD}}$ data access | | – | – | 80 | ns |
| t ₉ | $\overline{\text{HRD}}$ data to 3-state | | 5 | – | 60 | ns |
| t ₁₀ | $\overline{\text{HWR}}/\overline{\text{HRD}}$ to $\overline{\text{WAIT}}$ active | | – | – | 80 | ns |
| t ₁₁ | $\overline{\text{DTEN}}$ to $\overline{\text{HWR}}/\overline{\text{HRD}}$ | | 0 | – | – | ns |
| t ₁₂ | $\overline{\text{HWR}}/\overline{\text{HRD}}$ to $\overline{\text{DTEN}}$ inactive | for last data transferred; 33 MHz clock | – | – | 100 | ns |
| | | 16 MHz clock | – | – | 145 | ns |
| t ₁₃ | $\overline{\text{HWR}}/\overline{\text{HRD}}$ to $\overline{\text{EOP}}$ | only for last data access | – | – | 120 | ns |
| t ₁₄ | $\overline{\text{HWR}}/\overline{\text{HRD}}$ inactive to $\overline{\text{EOP}}$ inactive | only for last data access | – | – | 120 | ns |
| DRQ CONTROL DATA TRANSFER; see Fig.19 | | | | | | |
| t ₀ | $\overline{\text{HEN}}$ set-up | | 30 | – | – | ns |
| t ₁ | $\overline{\text{HEN}}$ hold | | 0 | – | – | ns |
| t ₂ | CMD set-up | | 15 | – | – | ns |
| t ₃ | CMD hold | | 5 | – | – | ns |
| t ₄ | $\overline{\text{HWR}}/\overline{\text{HRD}}$ active | 33 MHz clock | 50 | – | – | ns |
| | | 16 MHz clock | 75 | – | – | ns |
| t ₅ | $\overline{\text{HWR}}/\overline{\text{HRD}}$ data inactive | 33 MHz clock | 60 | – | – | ns |
| | | 16 MHz clock | 145 | – | – | ns |
| t ₆ | $\overline{\text{HWR}}$ data set-up | | 50 | – | – | ns |
| t ₇ | $\overline{\text{HWR}}$ data hold | | 20 | – | – | ns |
| t ₈ | $\overline{\text{HRD}}$ data access | | – | – | 80 | ns |
| t ₉ | $\overline{\text{HRD}}$ data to 3-state | | 5 | – | 60 | ns |
| t ₁₀ | DRQ to $\overline{\text{HWR}}/\overline{\text{HRD}}$ | | 0 | – | – | ns |
| t ₁₁ | $\overline{\text{HWR}}/\overline{\text{HRD}}$ to DRQ inactive | | – | – | 80 | ns |
| t ₁₂ | $\overline{\text{DTEN}}$ to $\overline{\text{HWR}}/\overline{\text{HRD}}$ | | 0 | – | – | ns |
| t ₁₃ | $\overline{\text{HWR}}/\overline{\text{HRD}}$ to $\overline{\text{DTEN}}$ inactive | for last data transferred; 33 MHz clock | – | – | 100 | ns |
| | | 16 MHz clock | – | – | 145 | ns |
| t ₁₄ | $\overline{\text{HWR}}/\overline{\text{HRD}}$ to $\overline{\text{EOP}}$ | only for last data access | – | – | 120 | ns |

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| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|---|----------------------------------|---------------------------|--------|------|------|------|
| t ₁₅ | HWR/HRD inactive to EOP inactive | only for last data access | – | – | 120 | ns |
| Oak compatibility mode host interface timing; see Fig.20 | | | | | | |
| COMIN, HCON WRITE AND SBOUT, TSTAT READ | | | | | | |
| t ₀ | HEN set-up | | 30 | – | – | ns |
| t ₁ | HEN hold | | 0 | – | – | ns |
| t ₂ | DMACK set-up | | 30 | – | – | ns |
| t ₃ | DMACK hold | | 0 | – | – | ns |
| t ₄ | address set-up | | 30 | – | – | ns |
| t ₅ | address hold | | 0 | – | – | ns |
| t ₆ | HWR/HRD active | 33 MHz clock | 50 | – | – | ns |
| | | 16 MHz clock | 75 | – | – | ns |
| t ₇ | HWR/HRD inactive | 33 MHz clock | 60 | – | – | ns |
| | | 16 MHz clock | 145 | – | – | ns |
| t ₈ | HWR data set-up | | 50 | – | – | ns |
| t ₉ | HWR data hold | | 20 | – | – | ns |
| t ₁₀ | HRD data access | | – | – | 80 | ns |
| t ₁₁ | HRD data to 3-state | | 5 | – | 60 | ns |
| RESET SUB-CPU; see Fig.21; note 4 | | | | | | |
| t ₀ | HEN set-up | | 30 | – | – | ns |
| t ₁ | HEN hold | | 0 | – | – | ns |
| t ₂ | DMACK set-up | | 30 | – | – | ns |
| t ₃ | DMACK hold | | 0 | – | – | ns |
| t ₄ | address set-up | | 30 | – | – | ns |
| t ₅ | address hold | | 0 | – | – | ns |
| t ₆ | HWR active | 33 MHz clock | 50 | – | – | ns |
| | | 16 MHz clock | 65 | – | – | ns |
| t ₇ | HWR inactive | 33 MHz clock | 60 | – | – | ns |
| | | 16 MHz clock | 145 | – | – | ns |
| t ₈ | HWR to SCRST | | – | – | 100 | ns |
| t ₉ | HWR inactive to SCRST inactive | | 512CLK | – | – | ns |
| NON-DMA DATA TRANSFER; see Fig.22; note 4 | | | | | | |
| t ₀ | HEN set-up | | 30 | – | – | ns |
| t ₁ | HEN hold | | 0 | – | – | ns |
| t ₂ | DMACK set-up | | 30 | – | – | ns |
| t ₃ | DMACK hold | | 0 | – | – | ns |
| t ₄ | address set-up | | 30 | – | – | ns |
| t ₅ | address hold | | 0 | – | – | ns |
| t ₆ | HWR/HRD active | 33 MHz clock | 50 | – | – | ns |
| | | 16 MHz clock | 75 | – | – | ns |

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| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|---|---|--------------|------|------|------|------|
| t ₇ | $\overline{\text{HWR}}/\overline{\text{HRD}}$ inactive | 33 MHz clock | 60 | – | – | ns |
| | | 16 MHz clock | 145 | – | – | ns |
| t ₈ | $\overline{\text{HWR}}$ data set-up | | 50 | – | – | ns |
| t ₉ | $\overline{\text{HWR}}$ data hold | | 20 | – | – | ns |
| t ₁₀ | $\overline{\text{HRD}}$ data access | | – | – | 80 | ns |
| t ₁₁ | $\overline{\text{HRD}}$ data to 3-state | | 5 | – | 60 | ns |
| t ₁₂ | cycle time | | 3CLK | – | – | ns |
| 8-BIT DMA DATA TRANSFER; see Fig.23 | | | | | | |
| t ₀ | $\overline{\text{DMARQ}}$ to $\overline{\text{DMACK}}$ | | 0 | – | – | ns |
| t ₁ | $\overline{\text{HWR}}/\overline{\text{HRD}}$ to $\overline{\text{DMARQ}}$ inactive | | – | – | 80 | ns |
| t ₂ | $\overline{\text{DMACK}}$ set-up | | 30 | – | – | ns |
| t ₃ | $\overline{\text{DMACK}}$ hold | | 0 | – | – | ns |
| t ₄ | $\overline{\text{HWR}}/\overline{\text{HRD}}$ active | 33 MHz clock | 50 | – | – | ns |
| | | 16 MHz clock | 75 | – | – | ns |
| t ₅ | $\overline{\text{HWR}}/\overline{\text{HRD}}$ inactive | 33 MHz clock | 60 | – | – | ns |
| | | 16 MHz clock | 145 | – | – | ns |
| t ₆ | $\overline{\text{HWR}}$ data set-up | | 50 | – | – | ns |
| t ₇ | $\overline{\text{HWR}}$ data hold | | 20 | – | – | ns |
| t ₈ | $\overline{\text{HRD}}$ data access | | – | – | 80 | ns |
| t ₉ | $\overline{\text{HRD}}$ data to 3-state | | – | – | 60 | ns |
| PSEUDO 16-BIT DMA READ TRANSFER; see Fig.24; note 4 | | | | | | |
| t ₀ | $\overline{\text{HRD}}$ to $\overline{\text{DMARQ}}$ inactive | | – | – | 80 | ns |
| t ₁ | $\overline{\text{DMARQ}}$ to $\overline{\text{DMACK}}$ | | 0 | – | – | ns |
| t ₂ | $\overline{\text{HRD}}$ inactive to $\overline{\text{DMACK}}$ inactive | | 0 | – | – | ns |
| t ₃ | $\overline{\text{HRD}}$ active | 33 MHz clock | 50 | – | – | ns |
| | | 16 MHz clock | 65 | – | – | ns |
| t ₄ | $\overline{\text{HFBC}}$ to data valid | | – | – | CLK | ns |
| t ₅ | data 3-state to $\overline{\text{HFBC}}$ inactive | | CLK | – | – | ns |
| t ₆ | $\overline{\text{HRD}}$ data access | | – | – | 80 | ns |
| t ₇ | $\overline{\text{HRD}}$ data to 3-state | | – | – | 60 | ns |
| t ₈ | $\overline{\text{HFBC}}$ active | | – | – | 5CLK | ns |
| t ₉ | data valid to $\overline{\text{HFBLB}}$ | | 2CLK | – | – | ns |
| t ₁₀ | $\overline{\text{HFBLB}}$ to $\overline{\text{HFBC}}$ inactive | | 2CLK | – | – | ns |

Notes

1. All timings are for single-speed, they should be divided by the speed up to eight times speed.
2. T represents half a clock period.
3. The timings for this mode can only be met with a 33 MHz clock.
4. CLK = 1 clock period.

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11.1 Q-to-W subcode interface timing

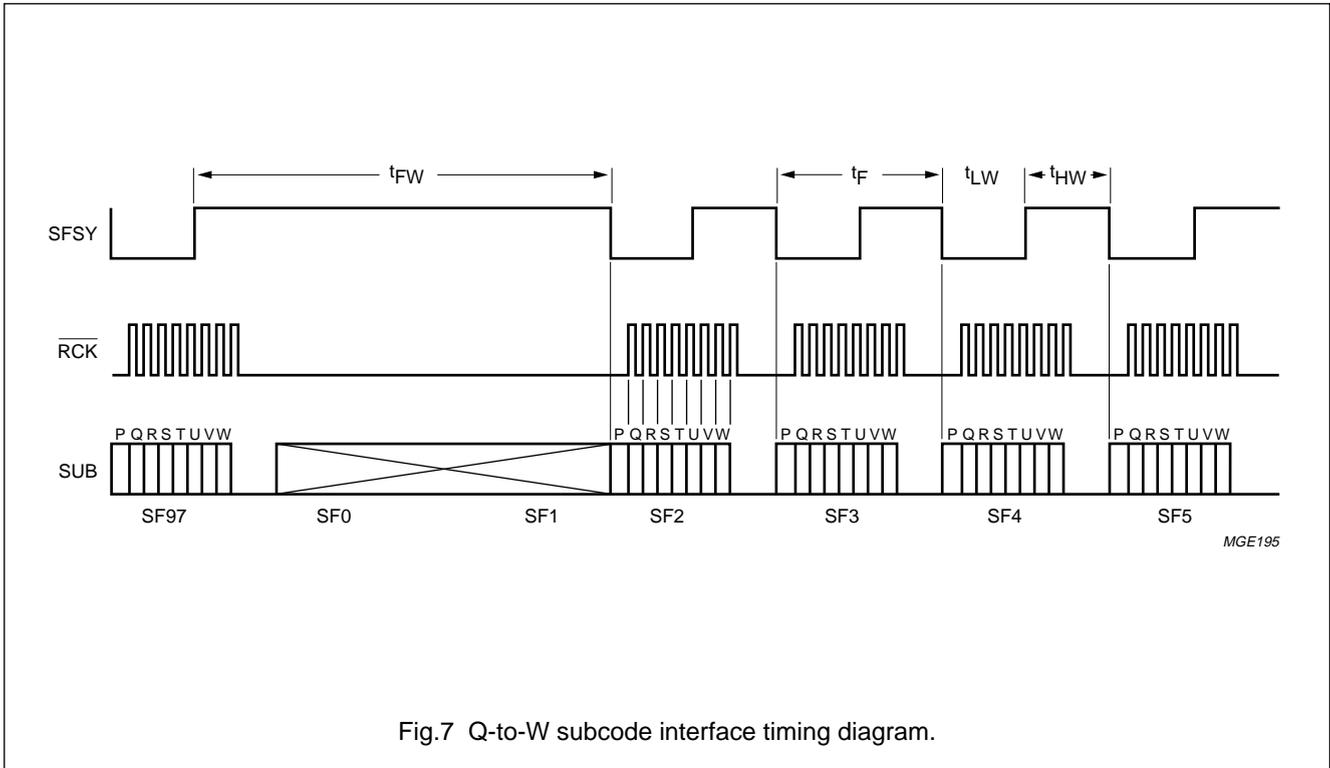


Fig.7 Q-to-W subcode interface timing diagram.

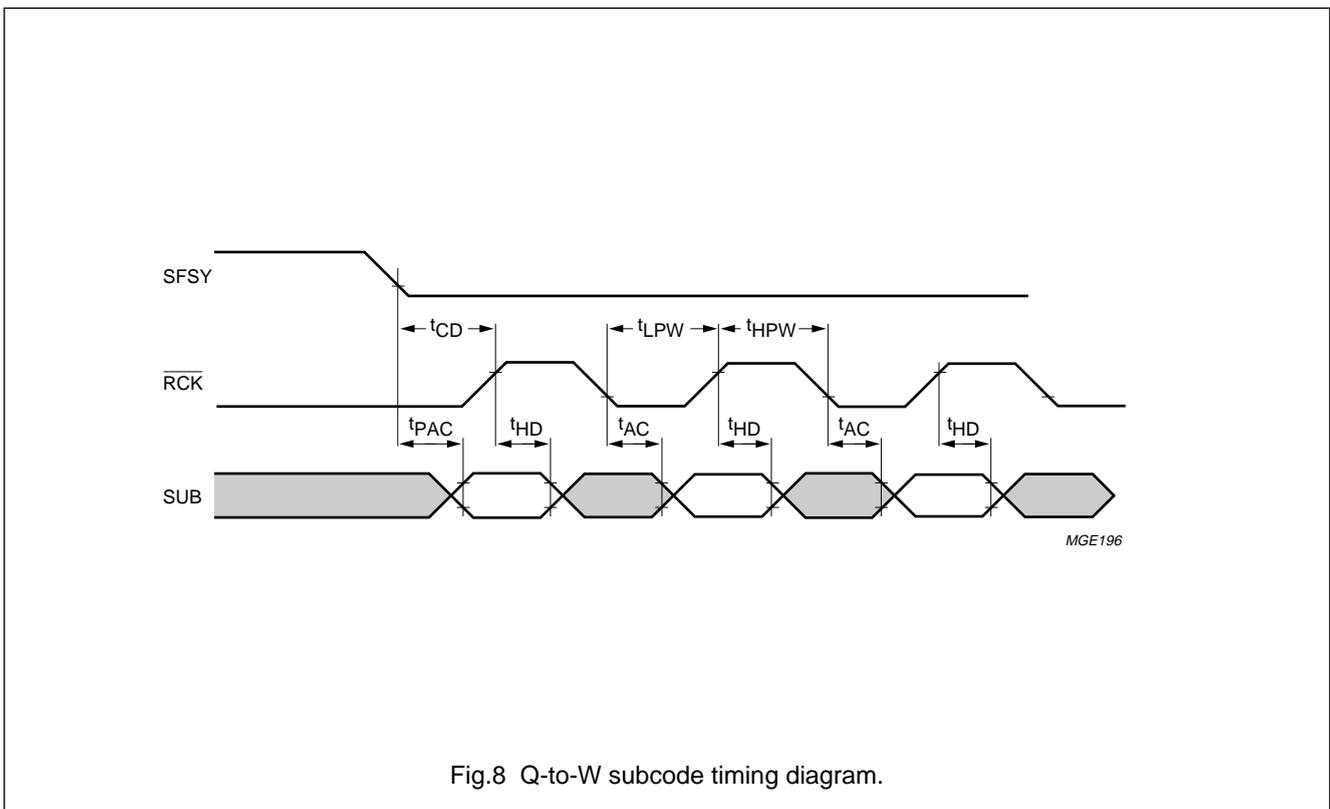


Fig.8 Q-to-W subcode timing diagram.

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11.2 External memory SRAM timing

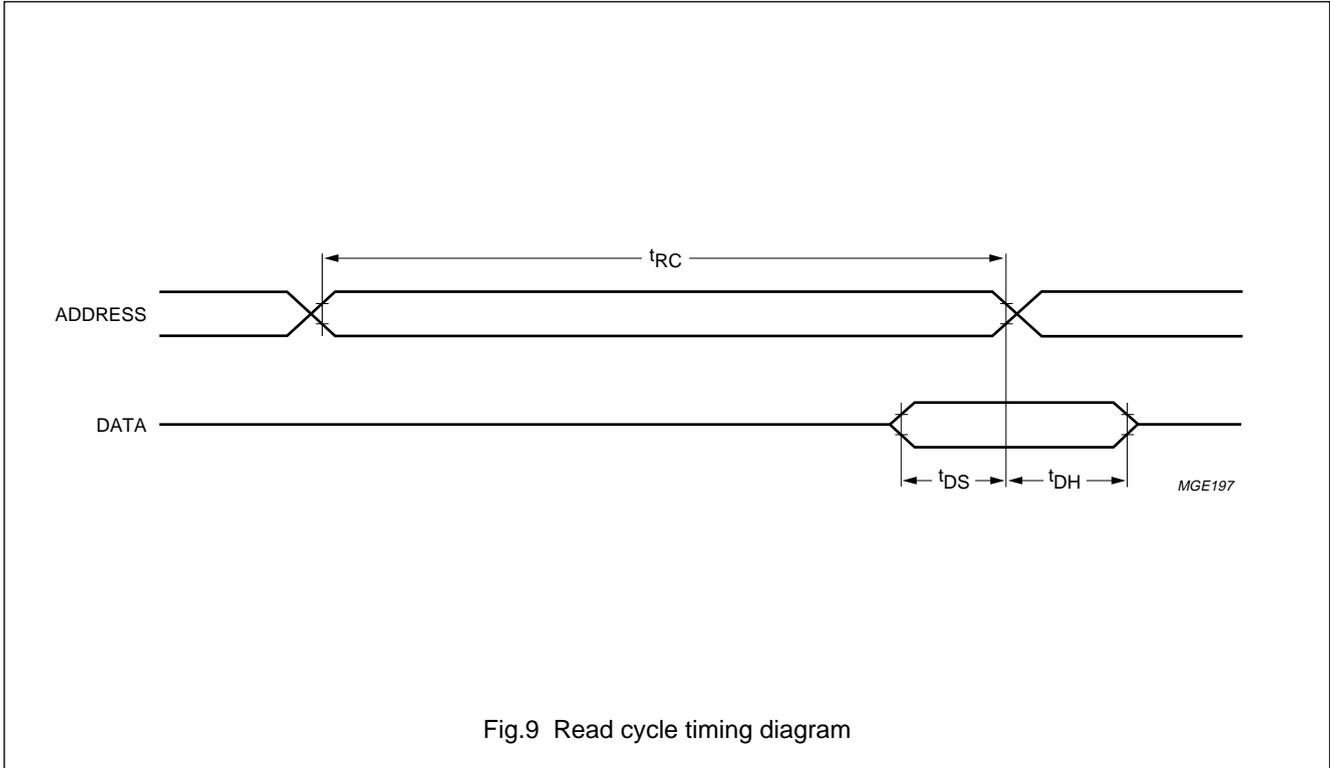


Fig.9 Read cycle timing diagram

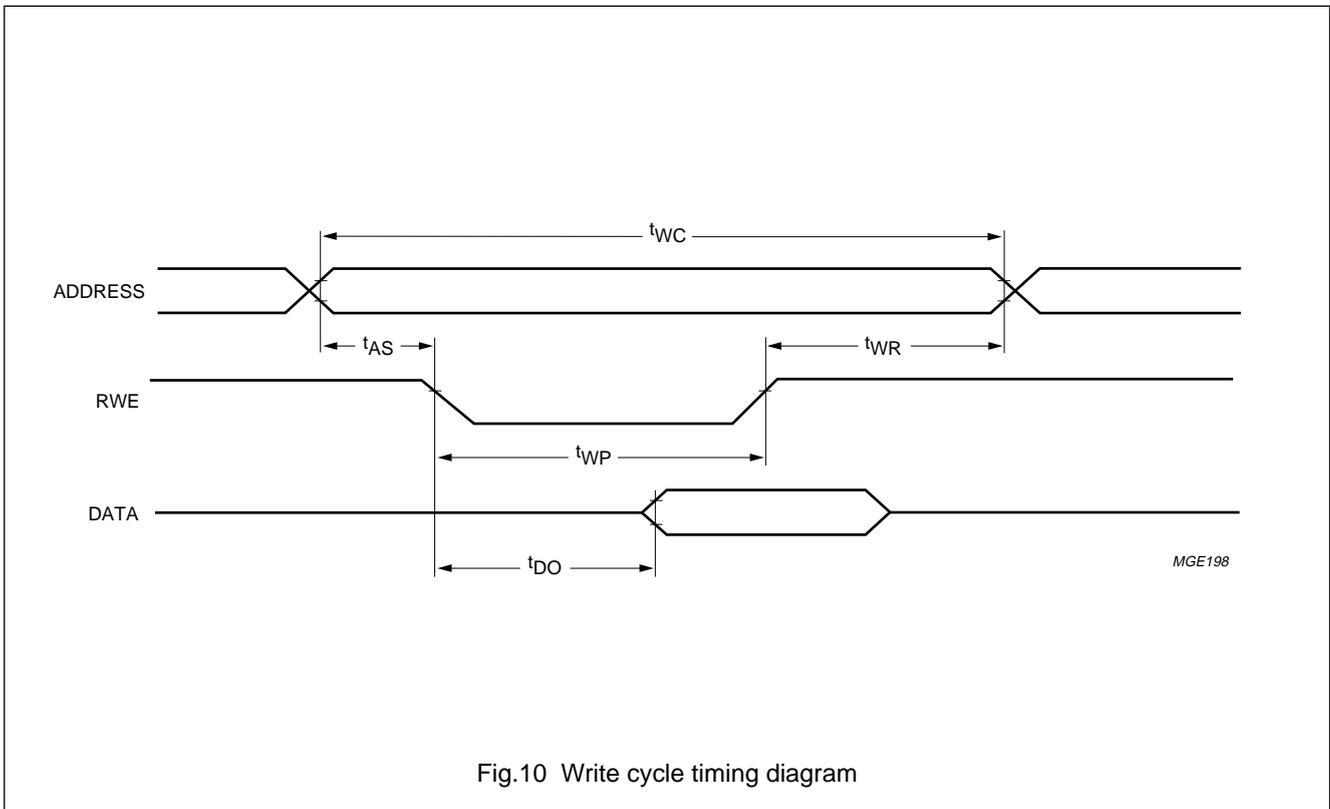


Fig.10 Write cycle timing diagram

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11.3 External memory DRAM timing

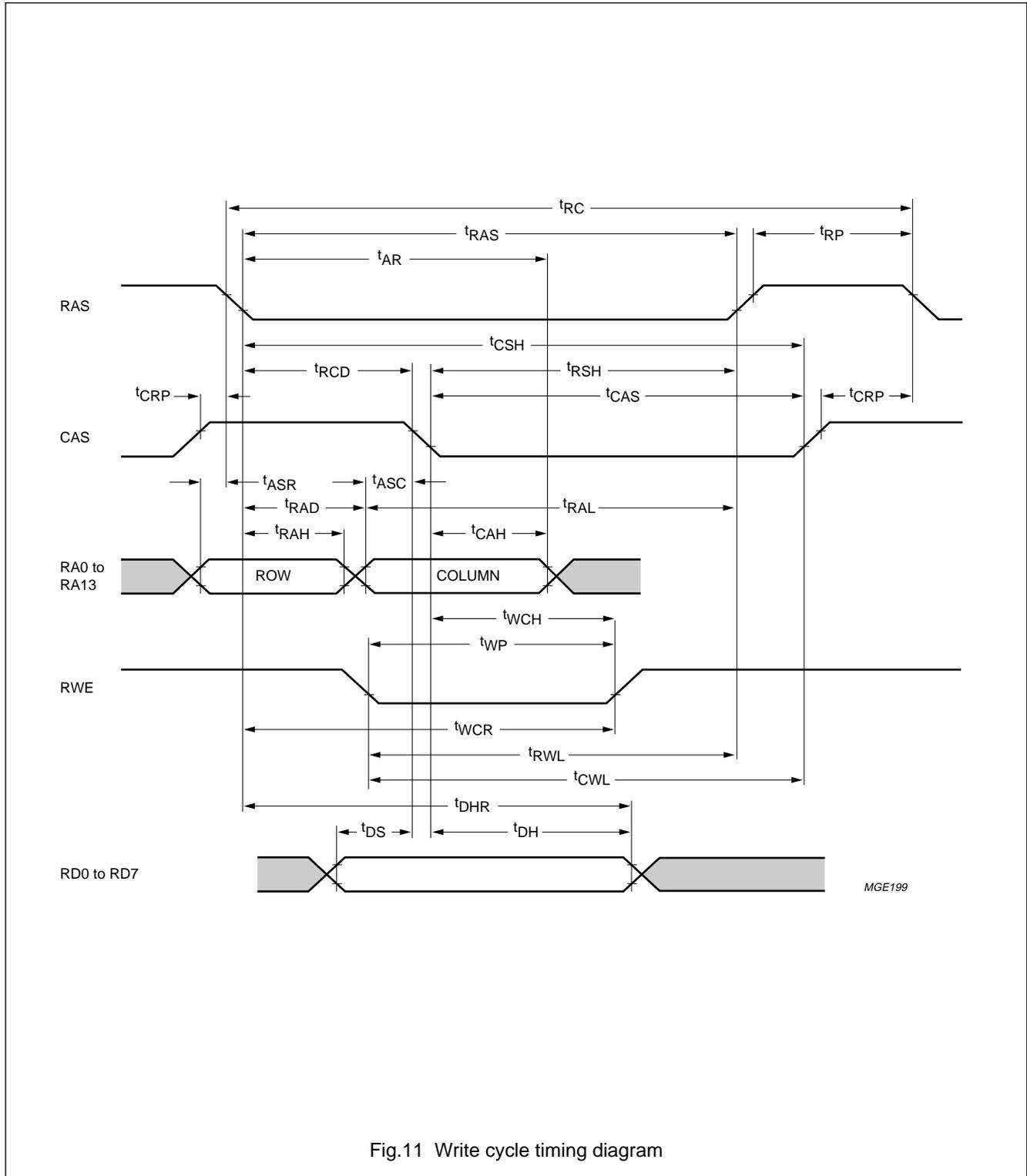


Fig.11 Write cycle timing diagram

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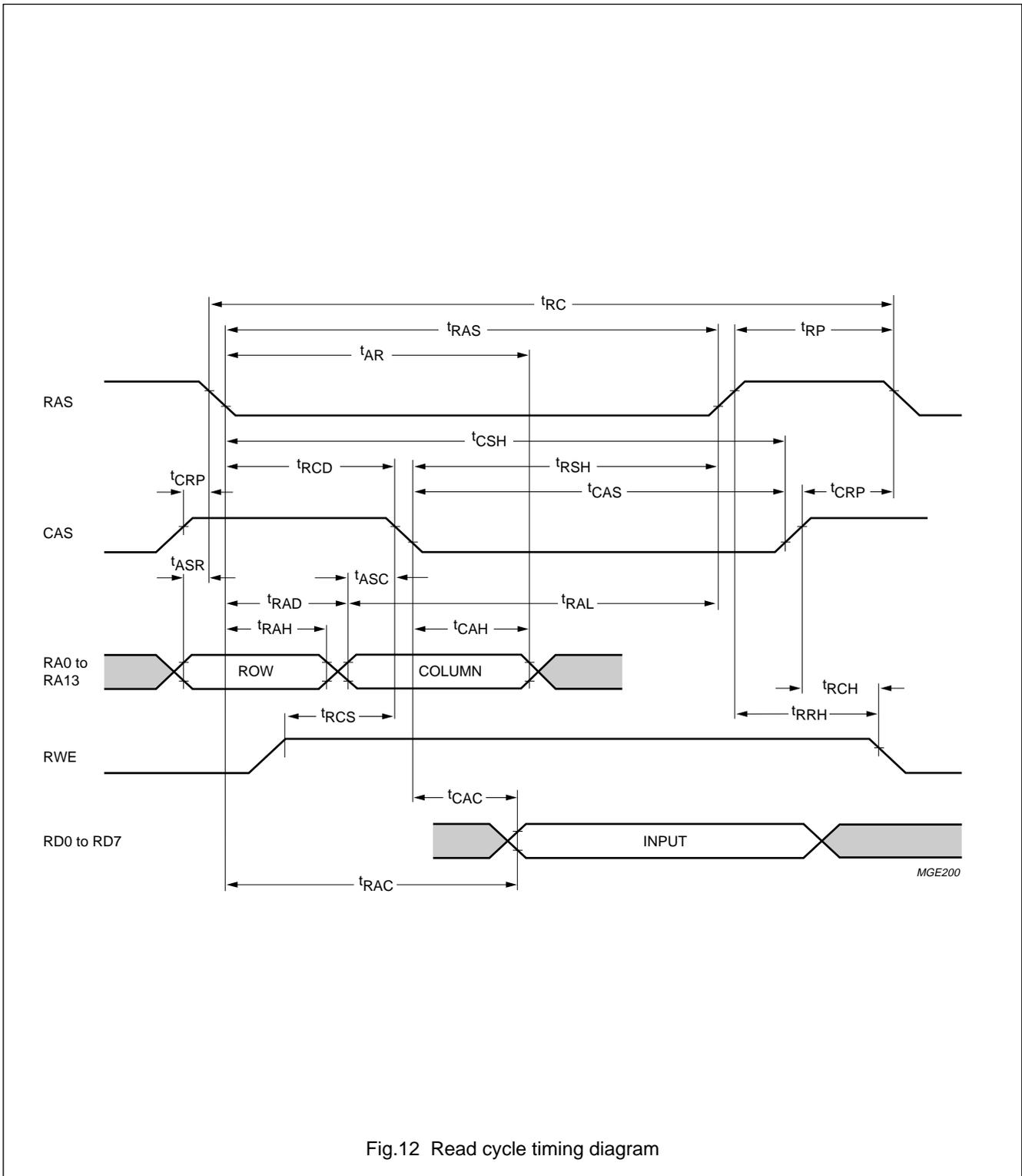


Fig.12 Read cycle timing diagram

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11.4 Sub-CPU interface timing

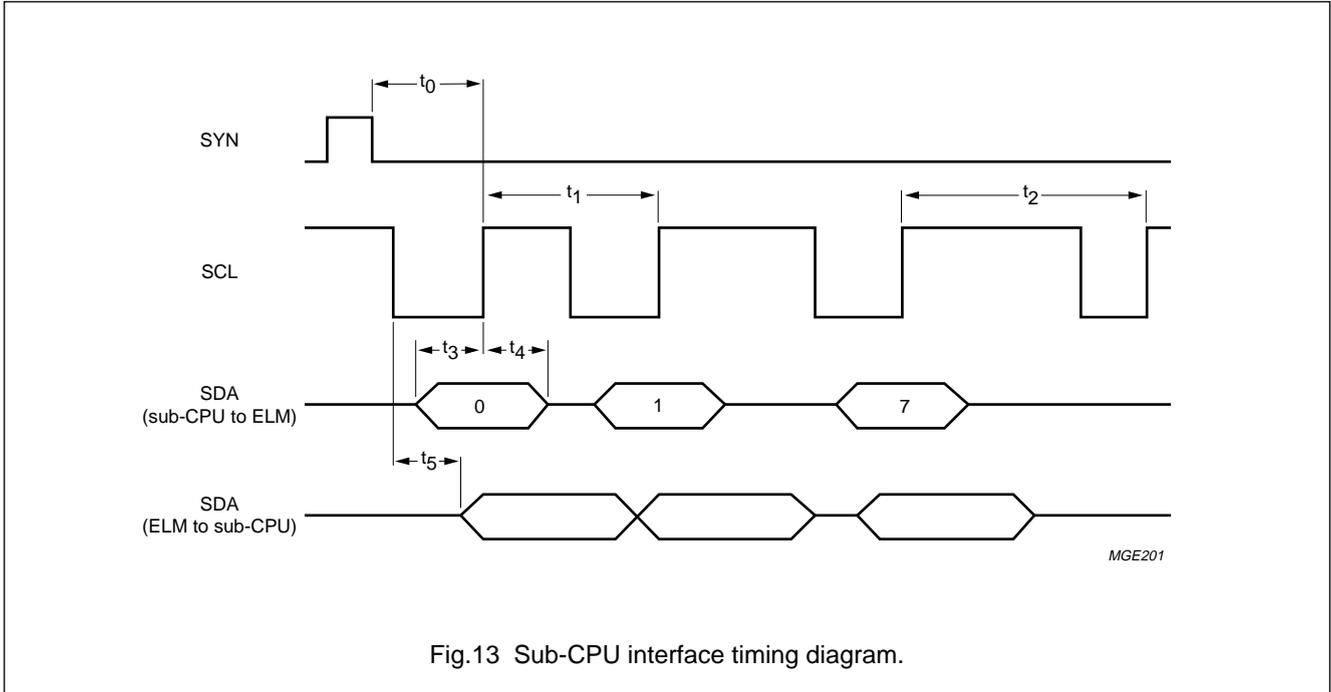


Fig.13 Sub-CPU interface timing diagram.

11.5 ATAPI host interface timing

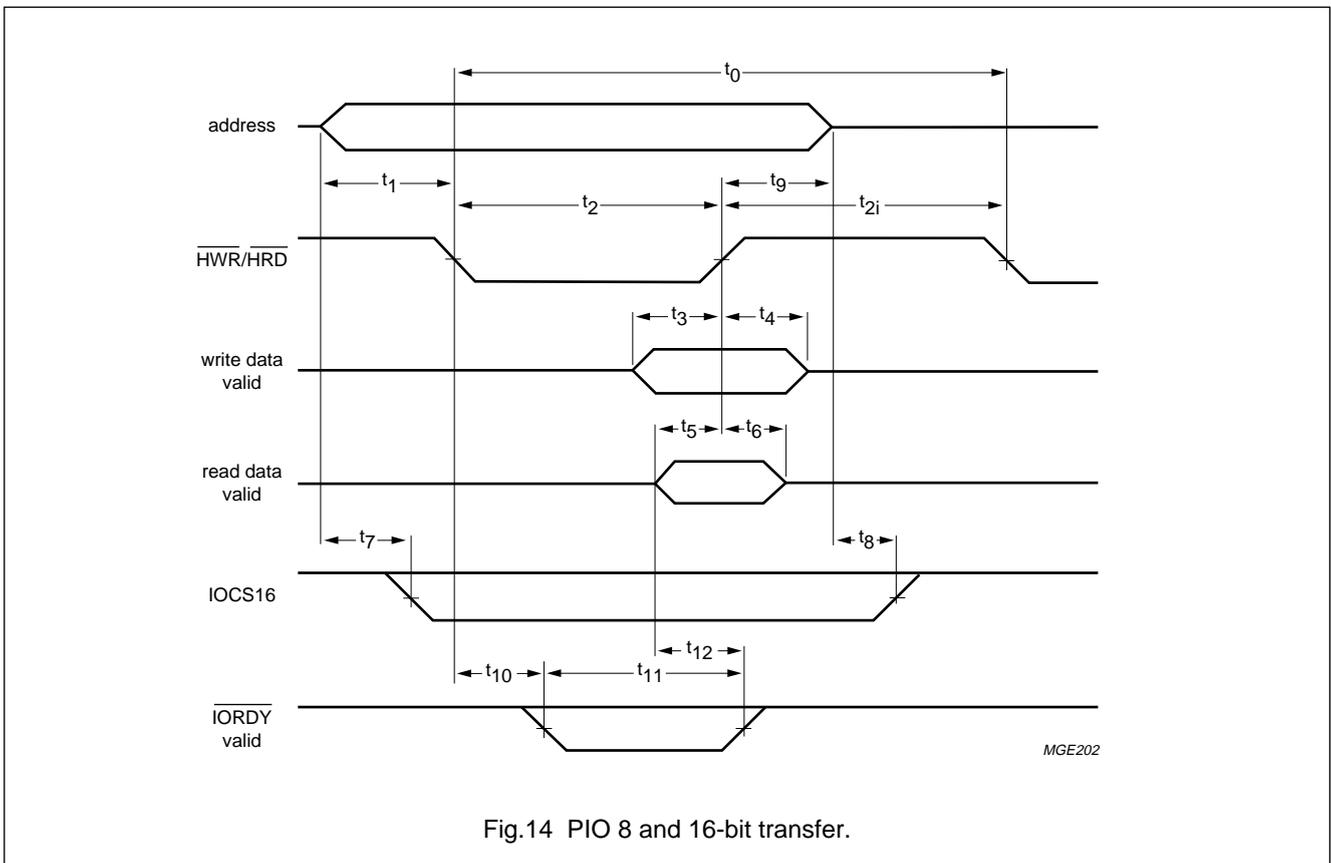


Fig.14 PIO 8 and 16-bit transfer.

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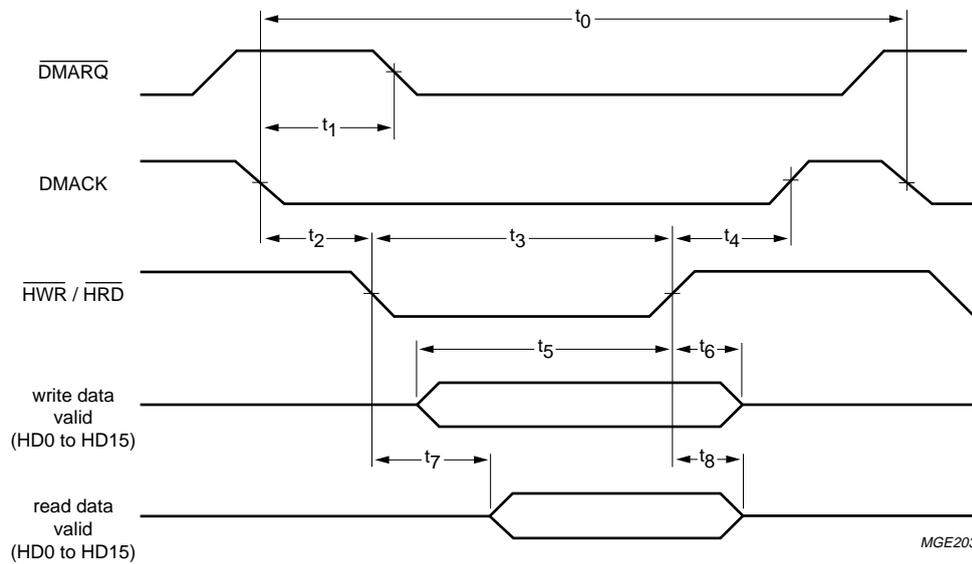


Fig.15 Single-word DMA transfer.

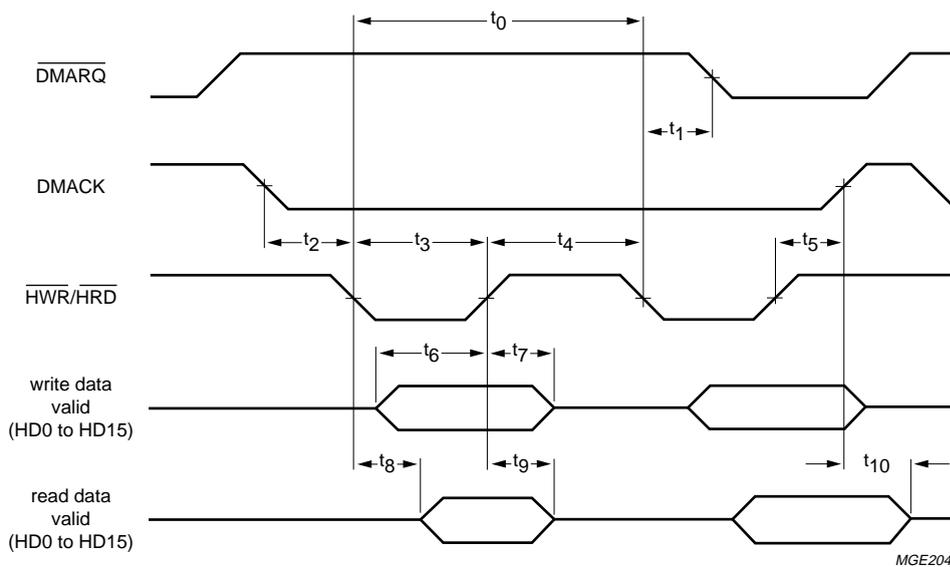


Fig.16 Multi-word DMA transfer.

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11.6 SANYO compatibility mode host interface timing

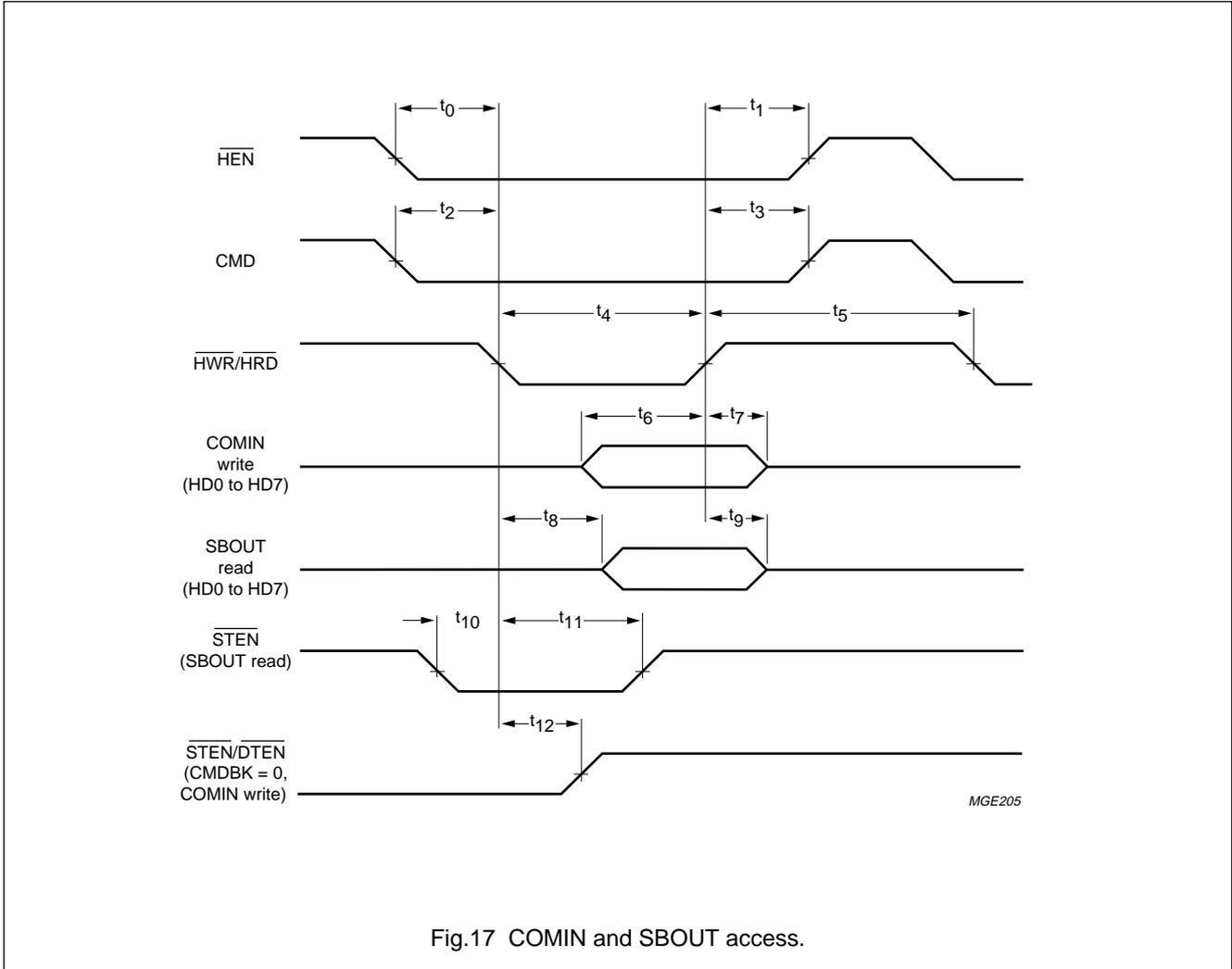


Fig.17 COMIN and SBOUT access.

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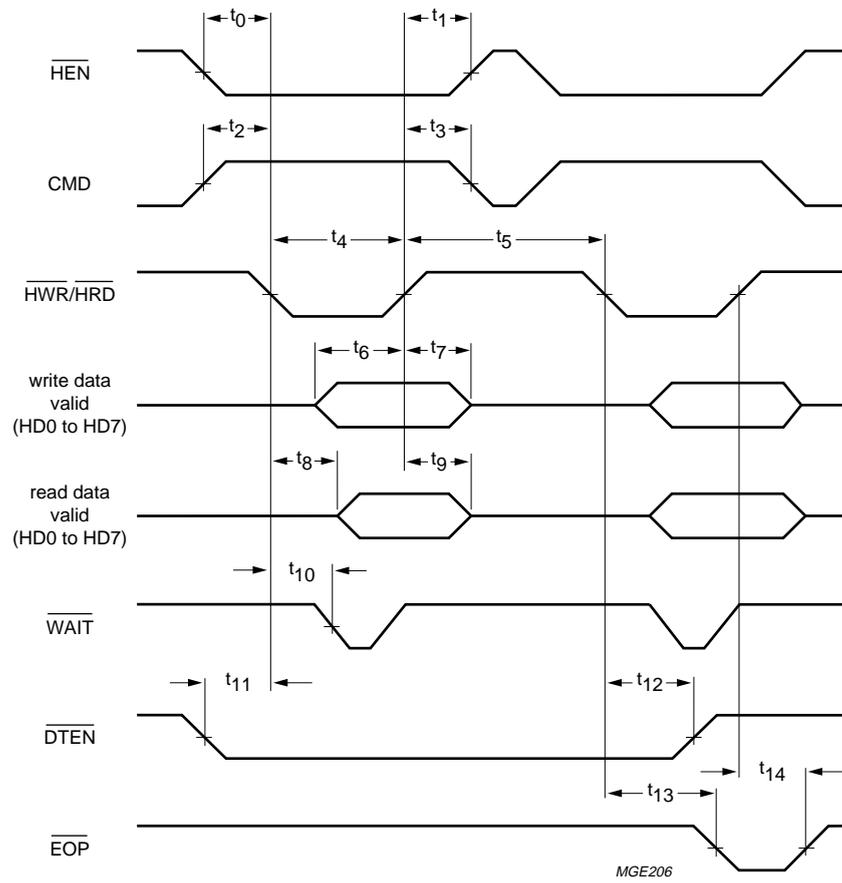


Fig.18 $\overline{\text{WAIT}}$ control and data transfer.

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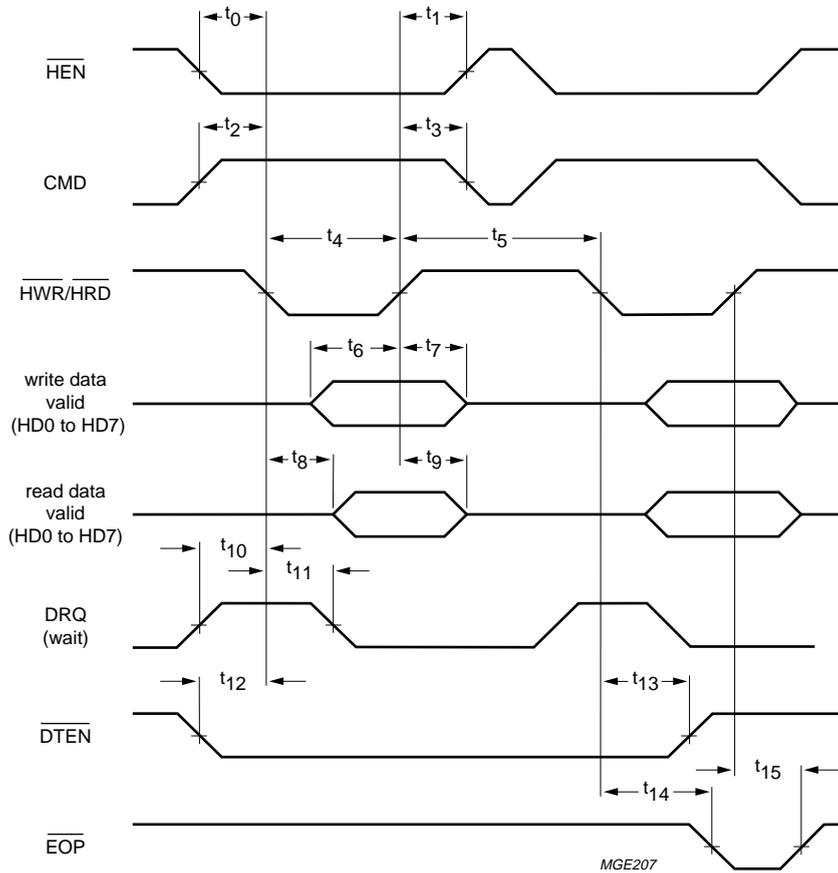
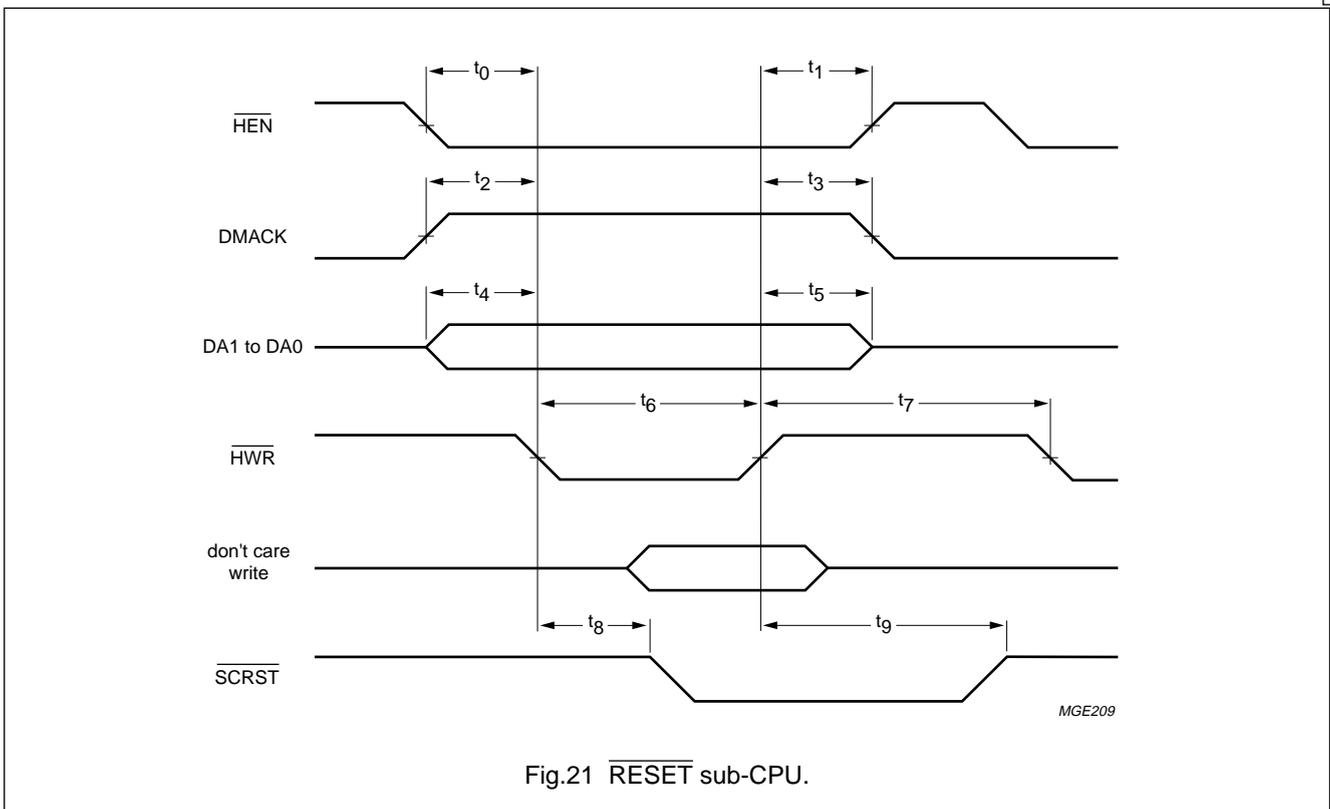
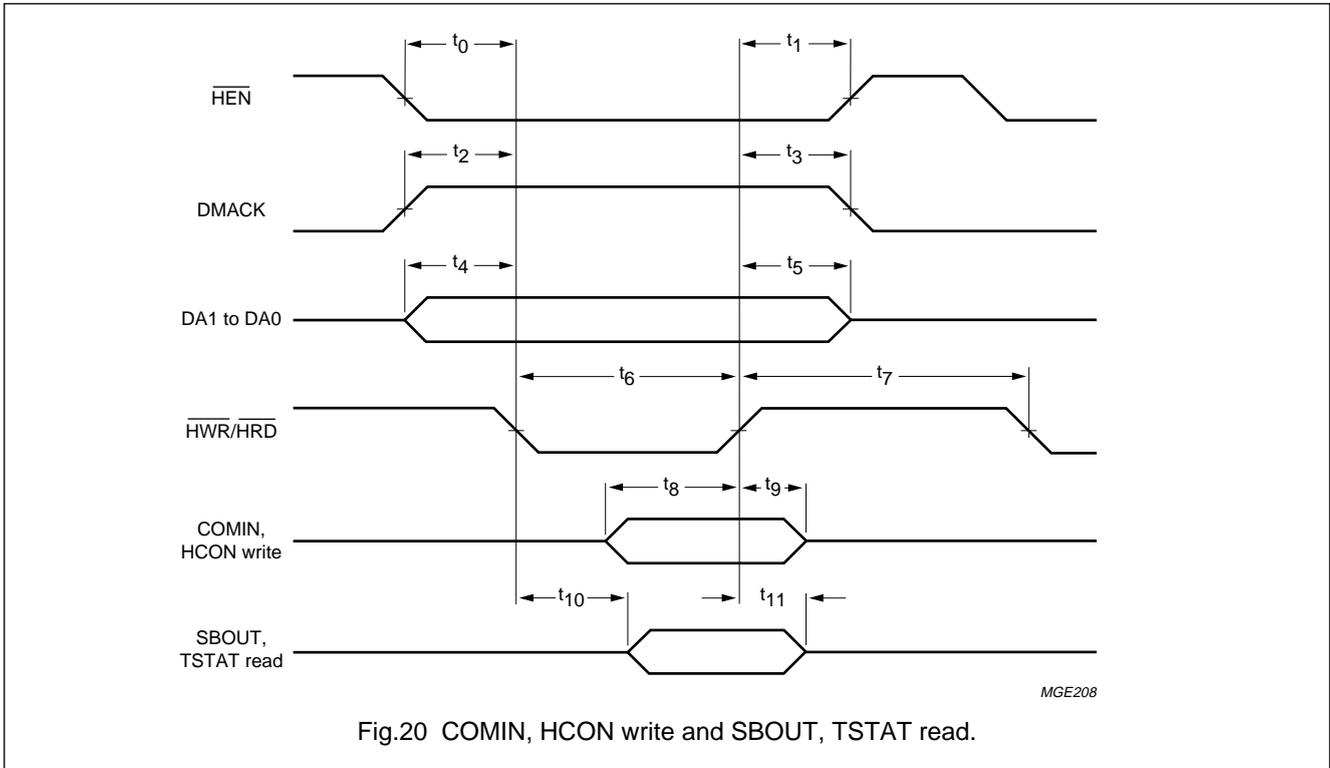


Fig.19 DRQ control data transfer.

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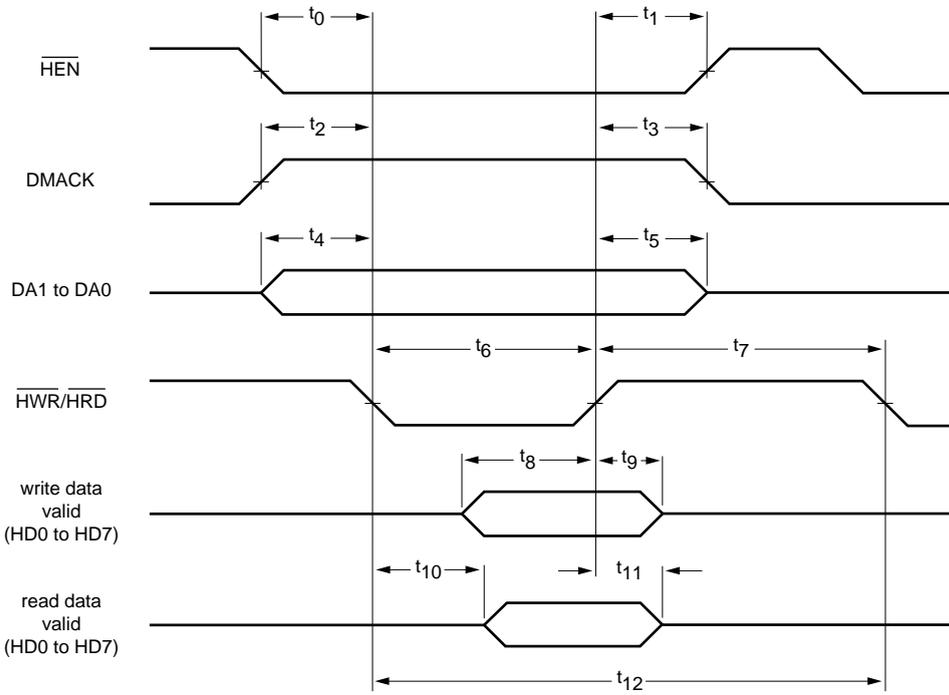
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11.7 Oak compatibility mode host interface timing



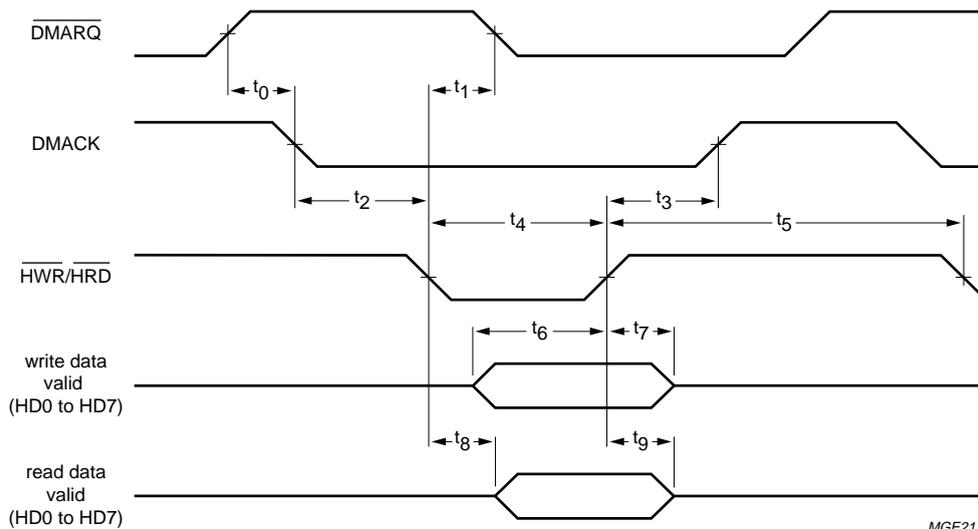
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MGE210

Fig.22 Non-DMA data transfer.



MGE211

Fig.23 8-bit DMA data transfer.

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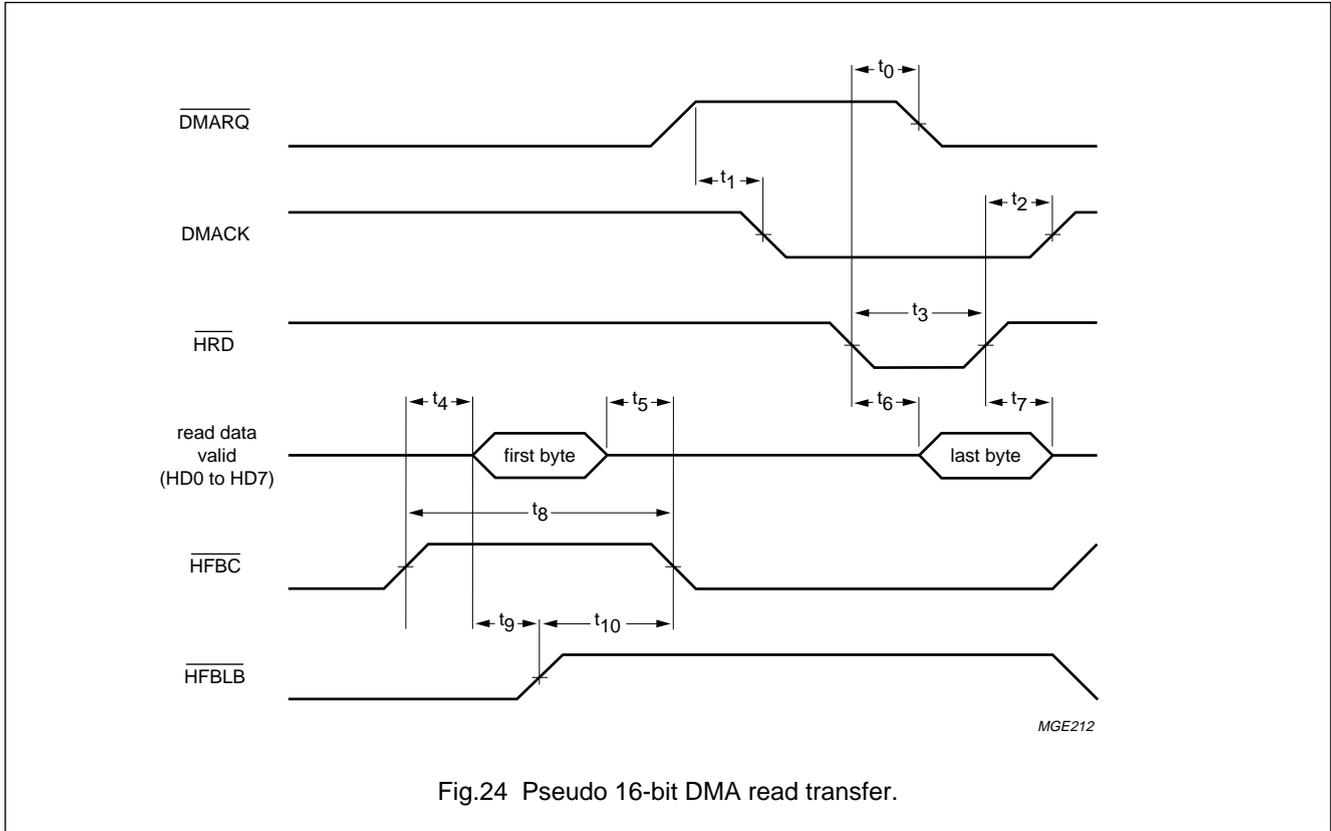


Fig.24 Pseudo 16-bit DMA read transfer.

11.8 Crystal oscillator

The crystal oscillator is a conventional 2 pin design operating at 15 to 50.4 MHz. This oscillator is also capable of operating with a ceramic resonator. It is capable of oscillating with both fundamental and third overtone mode crystals. External components should be used to suppress the fundamental output of the third overtone types as illustrated in Fig.25.

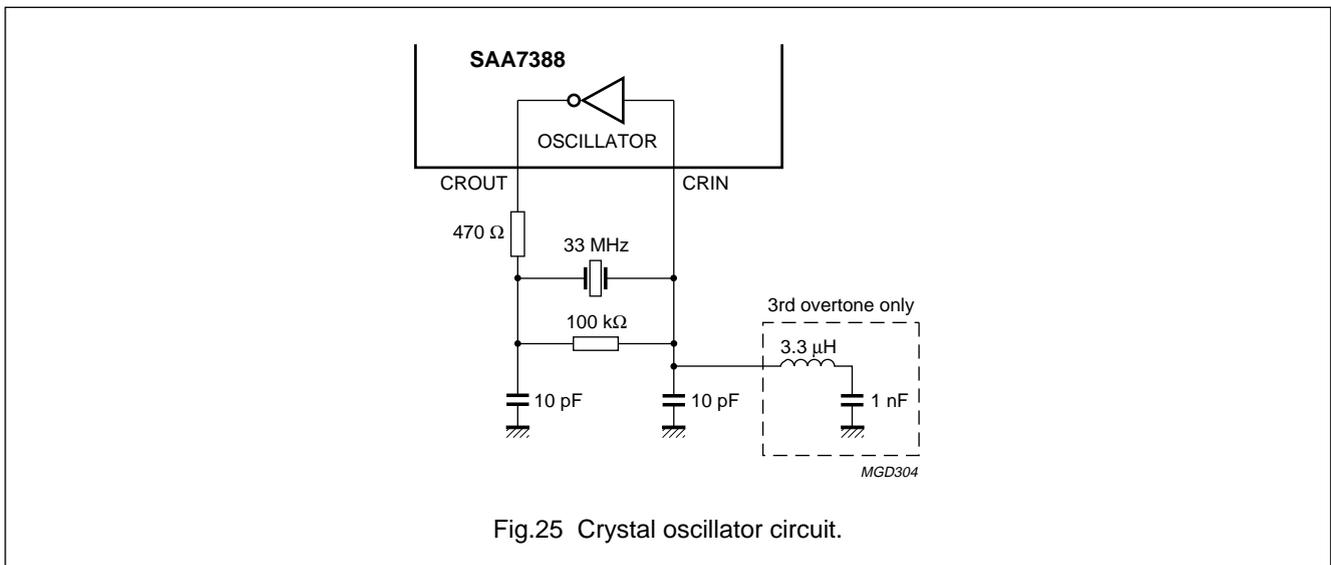


Fig.25 Crystal oscillator circuit.

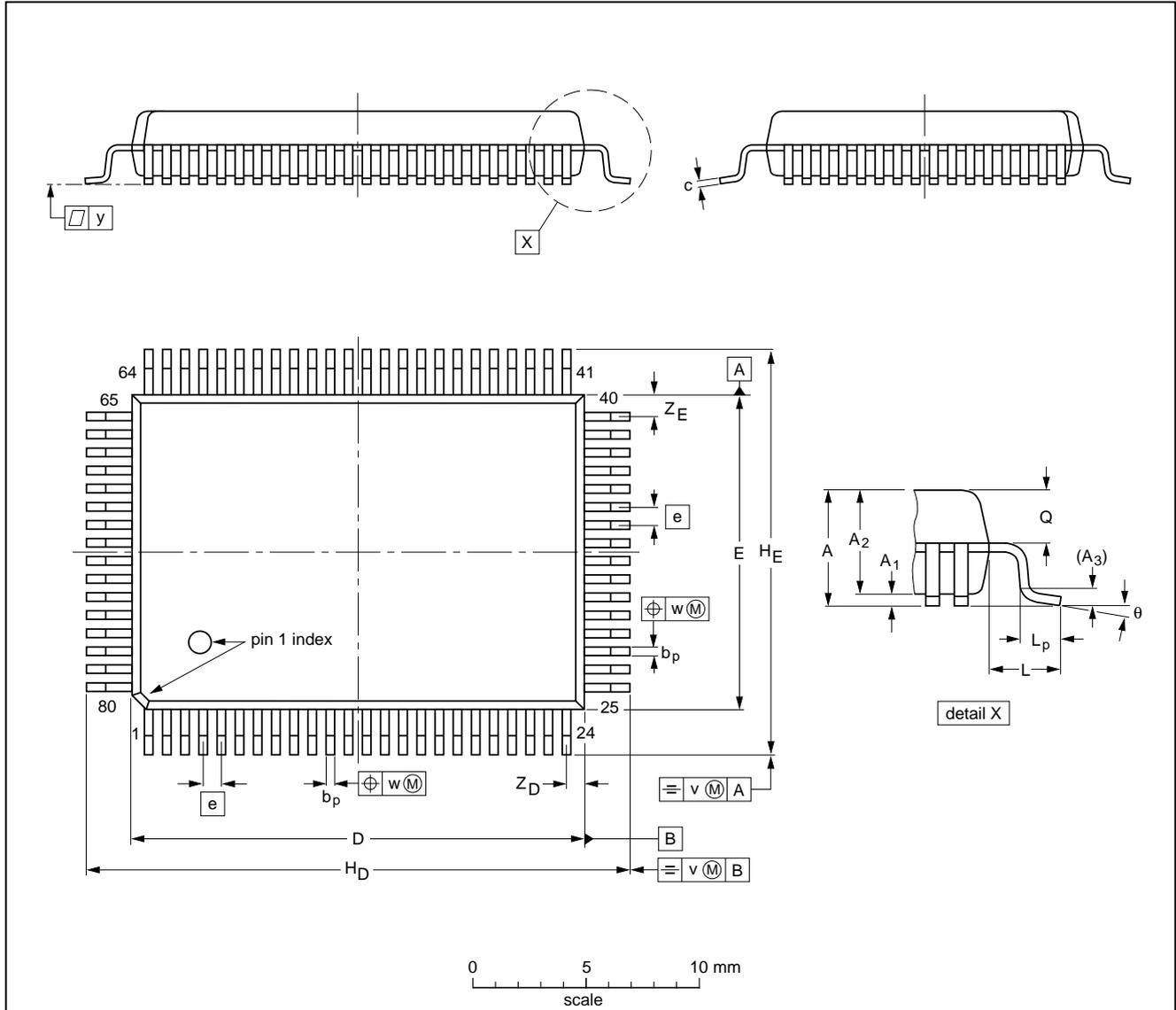
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12 PACKAGE OUTLINE

QFP80: plastic quad flat package; 80 leads (lead length 1.95 mm); body 14 x 20 x 2.8 mm

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DIMENSIONS (mm are the original dimensions)

| UNIT | A max. | A ₁ | A ₂ | A ₃ | b _p | c | D ⁽¹⁾ | E ⁽¹⁾ | e | H _D | H _E | L | L _p | Q | v | w | y | Z _D ⁽¹⁾ | Z _E ⁽¹⁾ | θ |
|------|--------|----------------|----------------|----------------|----------------|--------------|------------------|------------------|-----|----------------|----------------|------|----------------|------------|-----|-----|-----|-------------------------------|-------------------------------|----------|
| mm | 3.2 | 0.25 0.05 | 2.90 2.65 | 0.25 | 0.45 0.30 | 0.25 0.14 | 20.1 19.9 | 14.1 13.9 | 0.8 | 24.2 23.6 | 18.2 17.6 | 1.95 | 1.0 0.6 | 1.4 1.2 | 0.2 | 0.2 | 0.1 | 1.0 0.6 | 1.2 0.8 | 7° 0° |

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

| OUTLINE VERSION | REFERENCES | | | | EUROPEAN PROJECTION | ISSUE DATE |
|-----------------|------------|-------|------|--|---------------------|----------------------|
| | IEC | JEDEC | EIAJ | | | |
| SOT318-2 | | | | | | 92-12-15 95-02-04 |

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13 SOLDERING

13.1 Introduction

There is no soldering method that is ideal for all IC packages. Wave soldering is often preferred when through-hole and surface mounted components are mixed on one printed-circuit board. However, wave soldering is not always suitable for surface mounted ICs, or for printed-circuits with high population densities. In these situations reflow soldering is often used.

This text gives a very brief insight to a complex technology. A more in-depth account of soldering ICs can be found in our "IC Package Databook" (order code 9398 652 90011).

13.2 Reflow soldering

Reflow soldering techniques are suitable for all QFP and SO packages.

The choice of heating method may be influenced by larger plastic QFP packages (44 leads, or more). If infrared or vapour phase heating is used and the large packages are not absolutely dry (less than 0.1% moisture content by weight), vaporization of the small amount of moisture in them can cause cracking of the plastic body. For more information, refer to the Drypack chapter in our "Quality Reference Manual" (order code 9397 750 00192).

Reflow soldering requires solder paste (a suspension of fine solder particles, flux and binding agent) to be applied to the printed-circuit board by screen printing, stencilling or pressure-syringe dispensing before package placement.

Several techniques exist for reflowing; for example, thermal conduction by heated belt. Dwell times vary between 50 and 300 seconds depending on heating method. Typical reflow temperatures range from 215 to 250 °C.

Preheating is necessary to dry the paste and evaporate the binding agent. Preheating duration: 45 minutes at 45 °C.

13.3 Wave soldering

13.3.1 QFP

Wave soldering is **not** recommended for QFP packages. This is because of the likelihood of solder bridging due to closely-spaced leads and the possibility of incomplete solder penetration in multi-lead devices.

If wave soldering cannot be avoided, the following conditions must be observed:

- A double-wave (a turbulent wave with high upward pressure followed by a smooth laminar wave) soldering technique should be used.
- The footprint must be at an angle of 45° to the board direction and must incorporate solder thieves downstream and at the side corners.

Even with these conditions, do not consider wave soldering the following packages: QFP52 (SOT379-1), QFP100 (SOT317-1), QFP100 (SOT317-2), QFP100 (SOT382-1) or QFP160 (SOT322-1).

13.3.2 SO

Wave soldering techniques can be used for all SO packages if the following conditions are observed:

- A double-wave (a turbulent wave with high upward pressure followed by a smooth laminar wave) soldering technique should be used.
- The longitudinal axis of the package footprint must be parallel to the solder flow.
- The package footprint must incorporate solder thieves at the downstream end.

13.3.3 METHOD (QFP AND SO)

During placement and before soldering, the package must be fixed with a droplet of adhesive. The adhesive can be applied by screen printing, pin transfer or syringe dispensing. The package can be soldered after the adhesive is cured.

Maximum permissible solder temperature is 260 °C, and maximum duration of package immersion in solder is 10 seconds, if cooled to less than 150 °C within 6 seconds. Typical dwell time is 4 seconds at 250 °C.

A mildly-activated flux will eliminate the need for removal of corrosive residues in most applications.

13.4 Repairing soldered joints

Fix the component by first soldering two diagonally-opposite end leads. Use only a low voltage soldering iron (less than 24 V) applied to the flat part of the lead. Contact time must be limited to 10 seconds at up to 300 °C. When using a dedicated tool, all other leads can be soldered in one operation within 2 to 5 seconds between 270 and 320 °C.

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SAA7388**14 DEFINITIONS**

| | |
|---|---|
| Data sheet status | |
| Objective specification | This data sheet contains target or goal specifications for product development. |
| Preliminary specification | This data sheet contains preliminary data; supplementary data may be published later. |
| Product specification | This data sheet contains final product specifications. |
| Limiting values | |
| Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability. | |
| Application information | |
| Where application information is given, it is advisory and does not form part of the specification. | |

15 LIFE SUPPORT APPLICATIONS

These products are not designed for use in life support appliances, devices, or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips for any damages resulting from such improper use or sale.

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NOTES

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NOTES

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